

# SEMICON China / FPD China 2021 再相聚

March 17-19, 2021 SNIEC Shanghai, China

OSS: 2021年展位预定请到上海新国际博览中心内广场, E3展馆前  
“SEMICON China 2021展位预订”处



查询同期会议最新议程



快捷查询展商展位

\* Agenda is subject to change 最新活动议程以现场为准。

## NAURA 北方华创

展位号: E3433

### 带给产业无限可能

BRINGS OPEN FUTURE TO ALL

ETCH / PVD / CVD / FURNACE / WET / MFC / EPI / Anneal



# VISITOR GUIDE

## SEMICON<sup>®</sup> CHINA FPDCHINA 跨界全球·心芯相联

CONNECT COLLABORATE INNOVATE

2020年6月27日-29日

上海新国际博览中心

June 27-29, 2020 SNIEC, Shanghai



[www.semiconchina.org](http://www.semiconchina.org) [www.fpdchina.org](http://www.fpdchina.org)

### 上海精测半导体 Precision Measurement

膜厚测量机 / 全自动晶圆缺陷复查设备 / 双束系统

Film Thickness Measurement System / OCD  
Automatic Wafer Defect Review SEM / FIB-SEM Dual Beam

[www.pmish-tech.com](http://www.pmish-tech.com)



展位号  
E5511



**默克高性能材料业务及  
默克外高桥工厂(慧瞻材料科技(上海)有限公司)**

**默克公司：**德国默克集团是世界上历史最悠久的医药化工企业和全球知名的家族企业，其历史可追溯到1668年具有352年历史。今天的默克公司又是一家充满活力的全球领先的高科技企业跨国企业，专注于医药健康、生命科学和高性能材料三大领域。2019年全球总收入达162亿欧元，在全球66个国家与地区拥有约5万6000多名员工。

**默克中国：**默克在华的历史可追溯至1933年，已经深耕中国市场80余载，目前三大业务板块均在中国落地，并在全国拥有4000余名员工。自2015年起，默克在中国市场的业绩多年来连续保持两位数高速增长，同时也不断加大对中国市场的投入，近年五年来已经累计在华投资超过50亿元人民币。

**默克高性能材料业务**是一家全球领先的液晶生产商，也是新兴OLED显示材料领域的佼佼者，并在整个高端电子材料市场也拥有强大产品组合和广泛的业务布局，旗下目前拥有显示科技事业部、外观科技事业部、半导体材料事业部(先进材料与特殊气体)、电子材料供应系统，其各类高性能材料广泛应用于电视、手机、平板电脑等各类电子设备，以及半导体芯片制造、汽车、化妆品等行业。

默克高性能材料业务的产品组合主要集中于电子市场和数字经济，受益于5G、人工智能和物联网等新兴技术的发展，以及爆炸式增长的海量数据带来了显示技术和芯片技术的巨大需求。新材料和基于材料科学的创新将未来是推动数字化世界蓬勃向前的重要动力之一。

默克高性能材料的业务及在华发展战略跟中国政府的规划和中国的产业结构调整 and 布局息息相关、极其吻合。在中国充满活力的数字经济的驱动下，预计未来中国将占全球显示器产量的一半左右，中国也将崛起成为最重要的芯片制造基地之一。

**默克外高桥工厂(慧瞻材料科技(上海)有限公司)：**默克去年成功收购了慧瞻材料(Versum Materials)，进一步加强默克高性能材料业务在全球电子材料市场的领先地位。慧瞻材料是一家提供先进材料、特殊气体与设备于半导体产业供应商，同时也是全球领先的先进材料与特殊气体生产商。默克外高桥工厂是原慧瞻材料在中国的总部和主要运营基地，拥有一家新建的超高纯气体设备制造工厂、高纯度氮气供给工厂和保税半导体材料仓库，是一个集相关研发、生产、物流和客户服务于一体的综合性基地。目前该基地拥有80余名科研和工作人员，主要生产应用于半导体芯片制造的特殊电子材料、气体和相关设备，并提供相关的交付系统和服务，是中国集成电路产业链重要的一环和上海市重点高科技配套企业，直接广泛服务在华生产运营的诸多半导体芯片制造企业。

通过合作、创新和践行承诺，  
泛林集团助力芯片制造商构建更小、  
更快且性能更高的电子设备，  
成就科技未来。



欢迎关注泛林集团  
官方微信平台



Connect with us      

[www.lamresearch.com](http://www.lamresearch.com)



## 欢迎致辞



欢迎来到SEMICON 2020国际半导体展——全球规格最高、最具影响力的半导体“嘉年华”！内容覆盖了最新市场、技术及应用热点，期待您亲身体验、参与其中。

新冠疫情对全球经济产生了重大影响，但中国IC产业正在恢复中，今年下半年将持续成长。在这个关键时刻，作为2020电子半导体行业首展，SEMICON对国际半导体产业的推动，以及对国内半导体产业的复苏具有指标性的象征意义。

**全产业链覆盖：**展览面积达80,000多平方米，1,000家展商，4,000个展位。这是一个覆盖芯片设计、制造、封测、设备、材料供应商等全产业链携手合作，全球最具影响力的盛宴！

**最高规格：**今年的开幕主题演讲汇聚了中国及全球顶级行业领袖，畅谈全球产业发展趋势，市场热点以及技术应用。“SIIP China: SEMI产业创新投资论坛”集聚了IC产业基金、企业领袖、全球投资咨询机构的掌门人。

**聚焦市场热点的技术论坛：**“MSIG智能电动汽车芯片论坛”、“智能制造论坛”、“存储器发展论坛”、“功率及化合物半导体国际论坛”、“中国显示大会”等主题论坛覆盖半导体产业链、AI、5G、创新投资、存储器、智能汽车、智能制造、功率及化合物半导体、新型显示等领域。中国国际半导体技术大会（CSTIC）更是结合产学研的中国最具影响力的国际微电子技术论坛。

**云：**为了扩大国内外产业界的参与，我们部分会议将采用线下和线上直播相结合的方式，部分国外讲师将通过连线方式云分享。此外，我们还专门设置了SEMI产业云论坛，内容覆盖设备材料和地区专场。

**英才计划顺应产业需求：**半导体产业的持续健康发展，人才是关键因素。目前人才缺口问题已是全球性的挑战，正是基于此，“SEMI中国英才计划顾问委员会”力求保障中国半导体产业的创新力和持续发展动力。今年展会现场安排了WFD（英才计划）专区，以及展会同期的SEMI中国英才计划领袖峰会。

**本届展会的主题：跨界全球·芯芯相联！** SEMI的基本主张是自由贸易、开放的市场、知识产权保护和合作共赢，反对设置贸易壁垒，以维护产业的可持续发展。2020年是SEMI成立50周年，50年来SEMI和会员企业一起，共同推动半导体产业健康发展。作为帮助实现中国半导体梦想的合作伙伴，SEMI China充分利用独有的国际化合作平台优势，为会员企业及整个产业提供更多的价值。不管任何风云变幻，中国是全球最大的消费电子市场，让我们一起推动中国企业积极融入全球半导体产业链生态圈，推动产业持续前行！

居龙

SEMI全球副总裁、中国区总裁

## Welcome Message



Welcome to the SEMICON 2020, the world's most influential semiconductor trade show and forum.

The COVID-19 has had a major impact on the global economy, but the Chinese IC industry is recovering and will continue to grow in the second half of this year. SEMICON is the first exhibition of the electronic semiconductor industry in 2020, promoting the global semiconductor industry and carrying a symbolic significance for the recovery of the domestic semiconductor industry at this critical time.

**The Largest scale:** 80,000 square meters, 1,000 exhibitors, 4,000 booths. The event covers the whole electronics supply chain including chip design, manufacturing, assembly and test, equipment and materials.

**Top notch leadership-The Grand Opening Keynote** speeches features world-class industry leaders, who will explore the global business, technology, and market trend. “SIIP China: SEMI Innovation & Investment Forum” deliberates innovation, investment, and market hot topics.

**Other Concurrent forums** include “SEMI MSIG Smart Mobility Forum”, “Smart Manufacturing”, “Memory”, “Power & Compound Semiconductor” and “China Display Conference”, etc. **CSTIC 2020** continues as the most influential international microelectronics technical conference in China.

**Cloud-** Besides the on-site sessions, some forums will use online live broadcasts and some speakers will share their presentation online in order to expand the participation of domestic and foreign industry. A new SEMI industry @cloud platform has been set up for companies to showcase their technologies.

**Workforce Development-** SEMI China initiated “SEMI WFD Advisory Council” to address the talent gap by attracting and cultivating talents in the China semiconductor industry. **SEMI Workforce Pavilion** and **SEMI Workforce CXO Talent Forum** are the highlights this year.

**SEMI's mantra: Connect, Collaborate and Innovate.** SEMI's basic principles include free trade, open markets, IP protection, and win-win collaboration to help facilitate the sustainable development of the global electronics industry. 2020 is SEMI 50th anniversary. Over the past 50 years, SEMI and members have jointly promoted the healthy development of the semiconductor industry. SEMI China is committed to serve the China IC industry in continuing growth and integration into the global supply chain ecosystem as a partner. We look forward to an exciting future together!

Sincerely

Lung Chu  
President, SEMI China

## 精彩导读

开幕主题演讲 Grand Opening Keynote	01
SIIP China: SEMI产业创新投资论坛 SIIP China: SEMI Innovation and Investment Forum	02
SEMI中国英才计划领袖峰会 SEMI Workforce CXO Talent Forum	03
功率及化合物半导体国际论坛 2020 Power & Compound Semiconductor International Forum 2020	05
先进晶圆制造论坛 Advanced IC Manufacturing Forum	07
先进封装论坛 Advanced Packaging Forum	07
存储器发展论坛 Memory Strategic Forum	08
SEMI MSIG智能电动汽车芯片论坛——线上直播 SEMI MSIG Smart Mobility Forum-online Broadcast	09
智能制造论坛 Smart Manufacturing Forum	10
绿色厂务科技论坛 Green High-Tech Facility Forum	11
新技术发布会 New Technology Release Conference	13
光伏叠瓦技术与设备发展趋势研讨会 PV Shingled Technology and Equipment Developing Trend Seminar	15
光伏标准技术委员会2020春季会议 PV and PV Materials China Joint TC Chapter Spring Meeting 2020	15
2020 中国显示大会 - OLED or Micro LED 2020 China Display Conference - OLED or Micro LED	17
中国国际半导体技术大会 (CSTIC) China Semiconductor Technology International Conference	18
活动一览表 Schedule at a Glance	21
展馆平面图 Floor Plan	23
展商列表 Exhibitors List	37

# SEMI云官网

## 云直播、云培训、云招聘

### SEMI产业云论坛



扫码观看SEMICON/CSTIC会议直播

<http://v.semi.org.cn/>

## 展馆分布图 Pavilion Map



## 开幕主题演讲 | Grand Opening Keynote

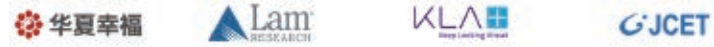
日期 Date: 2020年6月27日 周六 Saturday, June 27, 2020

时间 Time: 12:30-16:30

地点 Venue: 上海浦东嘉里大酒店, 上海厅1+2 Grand Shanghai Ballroom 1+2, Kerry Hotel Pudong, Shanghai

现场提供中英文同声传译 Chinese and English Simultaneous Interpretation will be provided

SPONSORS



**居龙 Lung Chu**  
SEMI全球副总裁、中国区总裁  
President, SEMI China  
Vice President, SEMI



**Ajit Manocha**  
SEMI总裁兼首席执行官  
President & CEO, SEMI



**Bertrand Loy**  
应特格微电子总裁兼首席执行官  
President and CEO, Entegris



**王宁 Wang Ning**  
中国电子商会会长  
President, CECC



**李毅中 Li Yizhong**  
中国工业和信息化部原部长  
中国工业经济联合会会长  
Chairman of China Federation  
of Industrial Economics



**陈捷 Jay Chen**  
东电电子(上海)有限公司  
总裁兼首席运营官  
President & COO,  
Tokyo Electron(Shanghai)Limited



**周子学 Zhou Zixue**  
中国半导体行业协会理事长  
Chairman, CSIA



**杨士宁 Simon Yang**  
长江存储首席执行长  
Chief Executive Officer, YMTC



**Marco Cassis**  
意法半导体市场销售、沟通和发展战略副总裁  
President, Sales, Marketing, Communications  
and Strategy Development,  
STMicroelectronics



**楚庆 Steve Chu**  
楚庆紫光展锐首席执行官  
Chief Executive Officer, UNISOC



**阿美利科·莱莫斯 Americo Lemos**  
格芯高级副总裁及亚洲业务发展负责人  
Senior Vice President, Asia Business  
Development and China Country  
President of GLOBALFOUNDRIES



**Georges Andary**  
博世汽车电子中国区总裁  
Regional President of Bosch  
Automotive Electronics China



**张素心 Zhang Suxin**  
上海华虹(集团)有限公司  
董事长, 党委书记  
Chairman, Shanghai Huahong  
(Group) Co., Ltd

## SIIP China: SEMI产业创新投资论坛

## SIIP China: SEMI Innovation and Investment Forum

日期 Date: 2020年6月28日 周日 Sunday, June 28, 2020

时间 Time: 09:30-16:45

地点 Venue: 上海浦东嘉里大酒店, 上海厅3 Grand Shanghai Ballroom 3, Kerry Hotel Pudong, Shanghai

现场提供中英文同声传译 Chinese and English Simultaneous Interpretation will be provided

DIAMOND  
SPONSORS



SILVER  
SPONSORS



【SIIP China: SEMI产业创新投资论坛2020】将邀请国家集成电路产业投资基金、01/02专项、地方基金以及产业基金的掌门人做主题演讲。本次论坛涵盖了深度学习、大数据、云计算、5G等对半导体产业发展的影响, 嘉宾们将探讨半导体制造、先进技术, 以及科创板将会对半导体产业带来怎样的巨大变化, 并共同展望中国半导体产业的前景。

### Introduction on ESDA介绍

2018年SEMI完成了对于ESDA的合并。多年以来, ESDA不遗余力推动半导体设计业的价值, 并成为促进全球电子产业进步至关重要的一关键技术。ESDA的加入使得SEMI如虎添翼, SEMI所覆盖的产业供应链, 及SEMI致力推动的垂直应用平台以及核心技术都由此得以延展和加强, 涵盖了智能交通、智能制造、智能数据、AI、5G以及机器学习等方面。



**丁文武 Ding Wenwu**  
国家集成电路投资基金  
总裁, 中国高端芯片联  
盟理事长



**梁胜 Liang Sheng**  
北京经济技术开发区  
管委会主任



**魏少军 Wei Shaojun**  
清华大学微电子学  
研究所所长



**沈伟国 Shen Weiguo**  
上海集成电路产业投资基金  
董事长, 上海科技创业投资  
(集团)有限公司董事总经理



**Handel Jones**  
CEO, International  
Business Strategies, Inc.



**Allan Gabor**  
Merck China President  
and Managing Director  
of Performance  
Materials China



**Christopher Thomas**  
Visiting Professor, Tsinghua  
University & Former Managing  
Partner, Asia Semiconductor  
Practice, McKinsey & Company



**Risto Puhakka**  
President of  
VLSIresearch



**张昕 Zhang Xin**  
中芯国际资深副总裁,  
中芯北方总经理,  
北方集成电路技术创新中心  
董事长



**陈大同 Chen Datong**  
璞华资本/元禾璞华  
投委会主席



**王晖 Wang Hui**  
盛美半导体设备(上海)  
股份有限公司董事长



**胡日新 Hu Rixin**  
上交所发行上市服务中心  
业务副总监; 长三角资本  
市场服务基地办公室主任;  
上海股权托管交易中心  
副总经理



**朱旭东 Xudong Zhu**  
上海浦东科技投资有限  
公司董事长、创始合伙人



**李炜 Wei Li**  
上海新昇半导体科技  
有限公司董事长



**李新荣 Allen Lee**  
AMD全球副总裁、  
中国研发中心总经理



**孟建熠 Jianyi Meng**  
平头哥半导体副总裁



**凌琳 Pete Ling**  
全球副总裁, 中国区  
总经理, Mentor,  
A Siemens Business



**王琦 Qi Wang**  
Cadence全球副总裁及  
南京凯鼎电子科技有限  
公司总经理



## SEMI中国英才计划领袖峰会 SEMI Workforce CXO Talent Forum

**SEMI 中国英才计划**  
SEMI Workforce Development China

日期 Date: 2020年6月29日 周一 Monday, June 29, 2020  
时间 Time: 09:30-12:30  
地点 Venue: 上海新国际博览中心, E7馆, 新技术舞台, SEMI中国英才计划展区  
Workforce Pavilion, New Tech Stage, Hall E7, Shanghai New International Expo Centre



全球半导体和电子制造业在吸引、留住和培养人才方面正面临越来越多的挑战，巨大的人才缺口成为了制约产业发展的关键因素。为了帮助产业吸引更多的半导体优秀人才，SEMI一直致力于全球推广“英才计划”。该计划旨在与半导体业界以及政府部门通力合作，通过吸引人才、留住人才以及培训人才的方式来保障半导体产业的创新力和持续发展。



**居龙 Lung Chu**  
SEMI全球副总裁、中国区总裁



**Ajit Manocha**  
President & CEO, SEMI  
SEMI总裁兼首席执行官



**张宗明 Melton Chang**  
施耐德电气数字能效事业部  
中国区负责人暨集团副总裁



**郭一凡 博士 Dr. Yifan Guo**  
日月光副总经理 IEEE Fellow



**许坚 Jason Xu**  
Edwards中国区客户  
中心总经理



**吴晓东 Michael Wu**  
韦尔(豪威)集团高级副总裁



**徐伟 Xu Wei**  
上海市集成电路行业协会秘书长



**刘二壮 博士 Dr. Erzhuang Liu**  
泛林集团副总裁兼中国区总经理



**赵甘鸣 博士 Dr. Ganming Zhao**  
应用材料公司半导体中国区  
事业部总经理, 应用材料中国区  
首席技术官



**施嘉诺 Jianou Shi**  
KLA副总裁兼中国区工程和研发  
中心总经理



**徐冬梅 Dongmei Xu**  
天水华天电子集团股份有限公司  
副总经理



**刘涛 Tracy Liu**  
KLA中国区人力资源总监

### Special Thanks to



## 一纳米定成败

您需要先进的XRF镀层测厚仪，即满足当前  
电子行业需求，也为将来纳米分析做准备。  
我们为以后的小型化装备提供高精度分析。

了解FT160



微信公众号



**FT160** ▶ **EA6000**

查看全系列产品：[hhtas.net/electronics](http://hhtas.net/electronics)  
销售热线：400 621 5191

## 功率及化合物半导体国际论坛 2020

### Power & Compound Semiconductor International Forum 2020

日期 Date: 2020年6月28-29日, 周日-周一 Sunday-Monday, June 28-29, 2020

时间 Time: 08:30-16:30

地点 Venue: 上海浦东嘉里大酒店, 浦东厅4 Pudong Ballroom 4, Kerry Hotel Pudong, Shanghai

现场提供中英文同声传译 Chinese and English Simultaneous Interpretation will be provided

#### SPONSORS



#### Day1-June 28th, 2020

08:30-09:15	Registration / 注册	Moderator / 主持人: Jiangbo Wang 王江波 VP, HC SemiTek Corporation 副总裁, 华灿光电(浙江)有限公司
09:20-09:30	Welcome Remark / 欢迎致辞 Lung Chu 居龙 President, SEMI China SEMI中国, 总裁	
	<b>Opening Keynote Session / 开幕主旨演讲</b>	
	Moderator / 主持人: David Xiao 肖国伟 CEO, APT Electronics 首席执行官, 广东晶科电子股份有限公司	
09:30-10:00	硅基氮化镓产业发展“芯”机遇 Weiwei Luo 骆薇薇 Board Chair, Innoscience (Zhuhai) Technology Co., Ltd. 董事长, 英诺赛科(珠海)科技有限公司	13:30-14:00 <b>Toward for Ultimate Displays with MicroLED (Virtual)</b> 迈向终极显示技术 - MicroLED (Virtual) Yun-Li (Charles) Li 李允立 CEO, PlayNitride 首席执行官, 臻创科技
10:00-10:30	GaN is Driving Changes in Automotive Systems (Virtual) 氮化镓技术如何推动车载系统的发展进程 (Virtual) Alex Lidow CEO and Co-founder, Efficient Power Conversion Corporation 首席执行官兼联合创始人, 美国宜普电源转换公司	14:00-14:30 <b>VCSELs and ToF Modules for 3D Sensing</b> 用于三维传感的VCSEL和ToF模块 Xiaoqi Chen 陈晓迟 General Manager, Vertilite Co., Ltd 总经理, 常州纵慧芯光半导体科技有限公司
10:30-11:00	How Cheap SiC Solution Can Be in The Near Future 碳化硅应用方案可以做到多便宜 Tong Chen 陈彤 CEO, Global Power Technology Co., Ltd. 总经理, 泰科天润半导体科技(北京)有限公司	14:30-15:00 <b>Application of Compound Semiconductor in Millimeter Wave Communication</b> 化合物半导体的毫米波通信应用 Chunjiang Li 李春江 Vice General Manager, Chengdu HiWafer Semiconductor Co., Ltd. 副总经理, 成都海威华芯科技有限公司
11:00-11:30	Enabling Solutions for High Volume Manufacturing of Wide Bandgap Materials 用于宽禁带半导体材料大规模生产的解决方案 Ziwen Fang 方子文 Senior Department Manager, AIXTRON SE 德国爱思强股份有限公司	15:00-15:30 <b>NAURA Solutions for Si Epitaxy and SiC Growth Applied for Power Devices</b> NAURA的Si外延和SiC材料在功率器件领域的解决方案 Boyu Dong 董博宇 Vice president&CVD Business Unit General Manager, Beijing NAURA Microelectronics Equipment Co.,Ltd 副总裁兼CVD事业部总经理, 北京北方华创微电子装备有限公司
11:30-13:30	Break / 休息	15:30-16:00 <b>Advanced Plasma Processing Solutions for High Performance VCSELs and EELs: Feature Etching and Thin Film Deposition. Enabling Cost Down Per Wafer and Critical Device Performance</b> 先进等离子加工技术于高性能VCSEL和EEL的解决方案: 特征蚀刻和薄膜沉积. 降低晶圆成本及关键设备性能

Robert Gunn  
Senior Product Manager - Etch, Oxford Instruments Plasma Technology  
蚀刻机高级产品经理, 英国牛津仪器

16:00-16:30 **GaN- A Key Technology for 5G**  
实现5G的关键技术-GaN  
Jenny Xun 荀颖  
FAE manager, Qorvo  
Qorvo

#### Day2-June 29th, 2020

#### Session: Wide Band Gap Semiconductors & Emerging Power Devices 宽禁带半导体及新型功率器件

	Moderator / 主持人: Aris Ma 马铁中 CEO, AK Optics Technology Co. Ltd 首席执行官, 昂坤视觉(北京)科技有限公司	Product Marketing Manager, ON Semiconductor 安森美半导体
09:00-09:30	<b>Opening Keynote Speech: Latest Packaging Developments Enhance Performance of Silicon Carbide (SiC) Power Devices (Virtual)</b> 用于加强碳化硅功率器件性能的最新封装技术 (Virtual) Filippo Di Giovanni STMicroelectronics 意法半导体	12:00-13:30 Break / 休息
09:30-10:00	<b>Technical Problems and Research Progress of SiC Power MOSFET</b> 碳化硅功率MOSFET技术问题及研究进展 Song Bai 柏松 Professor, Zhongdian Guoji South Co., Ltd. 教授级高工, 中电国基南方有限公司	13:30-14:00 <b>Navitas GaN Power ICs Drive Fast Charger Innovation and Market Adoption</b> 纳微高集成氮化镓功率芯片推动快充技术和市场的革新 Charles Zha 查莹杰 VP, General Manager of China, Navitas Semiconductor 副总裁, 中国区总经理, 纳微半导体
10:00-10:30	<b>Progress in Study and Industrialization of Wide Bandgap Semiconductor SiC Substrate</b> 宽禁带半导体碳化硅衬底研究和产业进展 Chunjun Liu 刘春俊 Vice President, CTO, TankeBlue Semiconductor Co., Ltd. 副总经理、技术总监, 北京天科合达半导体股份有限公司	14:00-14:30 <b>High Volume Manufacturing of Power Technologies(Virtual)</b> 功率技术的高产能制造(Virtual) Dustin Ho 何文彬 Technical Director, Silicon Product Group, Applied Materials, Inc 半导体产品事业部技术总监, 应用材料公司
10:30-11:00	<b>Recent Advances of ALD Technology for Power &amp; Compound Semiconductor Applications - A Prospect of Innovation and Localization in China</b> 原子层沉积技术在功率及化合物半导体的应用及国产化创新的展望 Wei-Min Li 黎微明 CTO, Jiangsu Leadmicro Nano Technology Co.,Ltd. 首席技术官, 江苏微导纳米股份有限公司	14:30-15:00 <b>Smart Integrations Maximizes the Performance of GaN Switches - Addressing the Challenge of Driving GaN</b> 智能集成最大化地提升了氮化镓开关性能-谈谈驱动氮化镓面临的挑战 Ye Xu 徐晔 Power Integrations, Inc.
11:00-11:30	<b>Advances in PVD Techniques for SiC and GaN Power Devices</b> 应用于碳化硅和氮化镓功率器件的PVD技术的进步 Michael Yi 易义军 SPTS Technologies	15:00-15:30 <b>Development of High Power SiC Power Modules for NEV and Traction Application</b> 用于新能源汽车和牵引应用的大功率SiC功率模块开发 Allen Wang 王浩 Technical Support Specialist, ABB China 技术支持专家, ABB中国
11:30-12:00	<b>ON Semiconductor SiC Solutions for Communications, Electric Vehicles and Solar Inverters</b> 安森美半导体碳化硅(SiC)方案服务于通信、电动汽车、太阳能逆变器市场 Raymond Wang 王利民	15:30-16:00 <b>Closing Keynote: 200mm/8-inch GaN Power Device and GaN-IC Technology: A New Opportunity for Wafer Suppliers, Foundries and IDMs (Virtual)</b> 8英寸GaN功率器件及IC技术: 晶圆供应商、代工厂、IDM厂商的新机遇 (Virtual) Denis Marcon IMEC
		16:00-16:20 <b>Lucky Draw 幸运抽奖</b>



## 先进晶圆制造论坛 | Advanced IC Manufacturing Forum

日期 Date: 2020年6月28日, 周日 Sunday, June 28, 2020  
 时间 Time: 09:00-12:00  
 地点 Venue: 上海浦东嘉里大酒店, 浦东厅1+2+3 Pudong Ballroom 1+2+3, Kerry Hotel Pudong, Shanghai

SPONSORS    

	Moderator / 主持人 Richard Jiang, VP, PNCS 蒋庭明, 副总裁, 至纯科技	<b>ume metrology and deep-learning technology</b> 袁伟, 上海集成电路研发中心, 技术研发部副部长 Wei Yuan, ICRD, Assistant Process technology Director
09:20-09:45	<b>Patterning solution on Advance node 先进技术的图形转换解决方案</b> Allan Chang, Vice President, NAURA 张正瑶, 副总裁, 北方华创	11:00 - 11:25 <b>THE BRIDGE of Fab &amp; Fabless</b> Actel Niu, Mentor, A Siemens Business, Account Technical Manager 牛风举, 明导电子, 资深技术经理
09:45 - 10:10	Dr. Jun He, VP, TSMC 何军, 副总裁, 台积电	11:25 - 11:50 Topic TBD Kong Tjien Lim, Director, Semiconductor, Thermo Fisher Scientific
10:10 - 10:35	<b>Opportunity of China's 300mm Wafer Supply 中国制造300毫米大硅片的机遇</b> Dr. Wei Li, Chairman, Zing Semiconductor Corporation 李炜 博士, 上海新昇半导体科技有限公司董事长	11:50 - 12:15 <b>Materials for Emerging Device Applications</b> Dan Tracy, Senior Director Market Research, TECHCET LLC
10:35 - 11:00	<b>Accurate etch modeling with high-vol-</b>	

## 先进封装论坛 | Advanced Packaging Forum

日期 Date: 2020年6月28日, 周日 Sunday, June 28, 2020  
 时间 Time: 13:00-16:30  
 地点 Venue: 上海浦东嘉里大酒店, 浦东厅1+2+3 Pudong Ballroom 1+2+3, Kerry Hotel Pudong, Shanghai

SPONSORS      

	Moderator/主持人 Dr. Adam He 何新宇 Executive Director, CGP Tech Fund 盛世投资, 执行董事	14:25-14:50 <b>The development of advanced materials for enabling packaging processes</b> Dr. Tianniu (Rick) Chen Head of Semiconductor Materials, Performance Materials division, Merck
13:00-13:10	<b>Opening remark / 开幕致辞 (Video)</b> Bill Bottoms Co-Chair of HIR, Chairman of 3MTS	14:50-15:05 Break
13:10-13:35	<b>5G环境下的微系统集成封装解决方案</b> Anderson Bao 包旭升 Vice President, Technical Marketing, JCET Group Co., Ltd 江苏长电科技技术市场副总裁	15:05-15:30 <b>Progress and Applications of 3D Wafer Level Packaging Technology 三维晶圆级封装技术进展和应用</b> Shuying.ma 马书英 President of Research Institute, Huatian technology (Kunshan) Electronics Co. LTD 华天科技(昆山)电子有限公司研究院副院长
13:35-14:00	<b>Progress of 3D Wafer Level Packaging and Integration Technologies for 5G Applications</b> Dr. Daquan Yu 于大全 Distinguished Professor of Xiamen University, CEO of Xiamen Sky Semiconductor Co., Ltd. 厦门大学特聘教授, 厦门云天半导体创始人	15:30-15:55 Reserved
14:00-14:25	Hong Xie 谢鸿 VP, TFME Research Institute of Advanced Packaging 通富先进封装研究院副总经理	15:55-16:20 <b>SiP Opportunities and Challenges Driven by Multiple Applications of 5G, AI and IoT 5G, AI, IoT 多重应用需求驱动下SiP的机遇与挑战</b> DeWen Tian 田德文 VP, business development, Goertek Microelectronics 歌尔微电子有限公司技术与商务副总裁
		16:20-16:30 <b>Closing remark / 闭幕演讲</b>

## 存储器发展论坛 | Memory Strategic Forum

日期 Date: 2020年6月29日, 周一 Monday, June 29, 2020  
 时间 Time: 08:45-12:00  
 地点 Venue: 上海浦东嘉里大酒店, 浦东厅1+2+3 Pudong Ballroom 1+2+3, Kerry Hotel Pudong, Shanghai

 现场提供中英文同声传译 Chinese and English Simultaneous Interpretation will be provided

SPONSORS    

08:45-09:15	Registration 来宾登记	10:10-10:35 <b>Keynote</b> Huabo Cai 蔡华波 Board Chairman 董事长 Longsys Electronics 江波龙电子
	Moderator / 主持人 Michael Chen 陈少民 Managing Director, Hina Group 汉能投资董事总经理	10:35-11:00 Jintie Li 李金铁 Vice President 中国区副总经理 Advantest 爱德万测试
09:20-09:45	<b>Emerging Memory Technologies and Solutions 新型存储器及解决方案</b> Xiaoping Shi 史小平 Technical Director PVD事业部CTO及工艺技术总监 NAURA北方华创	11:00-11:25 Dr. David Wang 王晖 Board Chairman 董事长 ACM Research 盛美半导体设备(上海)股份有限公司
09:45-10:10	<b>AI Memory for Data Intensive Applications 针对数据密集型应用之AI Memory</b> Dr. Alex Wang 王其国 President 总经理 Powerchip Technology Corporation 力晶科技股份有限公司	11:25-11:50 <b>Memory packaging technology 存储封装技术</b> Jianmin Li 李健民 Packaging R&D Director 封装技术开发总监 Amkor Assembly & Test (Shanghai) Co., Ltd. 安靠封装测试(上海)有限公司



**全套测试解决方案, 包括创新的MEMS探针!**



**全自动高速光学 3D/2D 检测装置 RWI300**



为高增长以及新兴市场提供支持  
技术路线图的测试解决方案。

通过测量和检测技术为制造业做出贡献,  
是我司日本电产理德株式会社的使命。



+81.75.315.8001  
www.nidec.com/cn/nidec-read  
Booth: T3125



**日本電産リード株式会社**  
NIDEC-READ CORPORATION



## SEMI MSIG智能电动汽车芯片论坛—线上直播 SEMI MSIG Smart Mobility Forum-online Broadcast

日期 Date: 2020年6月29日 周一 Monday, June 29, 2020

时间 Time: 09:50-16:30

现场提供中英文同声传译 Chinese and English Simultaneous Interpretation will be provided



We move to online broadcast! Easier for access!  
SEMICON云官网已上线, 扫描右侧二维码免费观看会议直播!

GAAC session: Outlook and trends of Auto revolution GAAC专题: 汽车变革趋势与展望	MSIG Sessions: MEMS&Sensors for Electrification and intelligence MSIG专题: 车用MEMS传感器
09:50-10:00 <b>GAAC Opening remark</b> Bettina Weiss Chief of Staff, SEMI	14:30-14:45 <b>MSIG Opening remark</b> Tim Brosnihan Executive Director, SEMI MSIG
10:00-10:25 <b>Keynote: Risks&amp; Opportunities for Auto Semiconductor</b> 主题演讲: 汽车半导体的风险与机会 JACK H.T. CHENG 郑显聪 Co-founder, Nio 蔚来联合创始人	14:45-15:10 <b>Keynote: MEMS and sensors in automotive application</b> 主题演讲: 汽车应用中的MEMS和传感器 Benedetto VIGNA President, Analog, MEMS and Sensors Group, STMicroelectronics
10:25-10:50 Leopold Beer VP Product Management Automotive Electronics, Bosch Automotive	15:10-15:35 <b>Indispensable MEMS Technology In Autonomous Driving</b> 自动驾驶中不可或缺的MEMS技术 Yanhui Zhao 赵延辉 ASIA MEMS Product Line Director, Analog Devices, Inc. ADI亚太区微机电产品线总监
10:50-11:15 <b>车规级AI芯片赋能汽车智能化变革</b> Stanley Li 李星宇 Vice President of Business Development & Strategic Planning, Horizon Robotics 地平线市场拓展与战略规划副总裁	15:35-16:00 <b>Novel sensors for automotive lifestyle, comfort and safety</b> 提升汽车品味, 舒适和安全的新型传感器 Christian Bachmann Program leader, ULP Wireless Systems, IMEC
11:15-11:40 Dr. Alex Gu 古元冬 SVP, Shanghai Industrial QTechnology Research Institute(SITRI)	16:00-16:25 <b>How engineered substrates empower automotive innovation?</b> 优化衬底如何赋能汽车创新? Wanpeng Zhang 张方鹏 Strategic development head of China, Soitec Soitec中国区战略发展负责人
11:40-12:05 LeiLei Shinohara 篠原磊磊(TBD) R&D VP, RoboSensor 速腾聚创研发副总裁	
12:05-13:30 Break	
13:30-14:15 <b>Panel discussion: Opportunities in auto ecosystem beyond 2020</b> 圆桌讨论: 未来汽车生态的机会	

## 智能制造论坛 | Smart Manufacturing Forum

日期 Date: 2020年6月28日, 周日 Sunday, June 28, 2020

时间 Time: 13:00-16:35

地点 Venue: 上海新国际博览中心, E7馆, 新技术舞台  
New Tech Stage, Hall E7, Shanghai New International Expo Centre

SPONSORS



Moderator / 主持人 James Zheng 郑加锁 博士 Chairman, Xuzhou Xinjing Semiconductor 徐州鑫晶半导体有限公司, 董事长	14:45-15:10 <b>Intellectual Manufacturing</b> 卓越制造 Andy HAN 韩迪 Vice President, SMIC 副总裁, 中芯国际集成电路制造有限公司
13:00-13:15 Registration	15:10-15:35 <b>Smart Manufacturing Practice in Semiconductor Industry</b> 半导体行业智能制造应用实践 Jun HE 何军 TCL VP & Getech CEO, Getech Technology CO.,LTD. TCL副总裁&格创东智首席执行官, 格创东智科技有限公司
13:15-13:30 Welcome Speech 欢迎致辞	15:35-16:00 <b>Everyone is A Data Scientist</b> 人人都是数据科学家 Brown RUI 王文瑞 CTO, Shanghai Glorysoft Co., Ltd. 首席技术官, 上海哥瑞利软件有限公司
13:30-13:55 <b>Shaping China's Pursuit of Semiconductor Independency with New Manufacturing System Innovations</b> 借力2020半导体智造“芯”机遇, 创建国产智造系统“新”思维 MK KOH 许明光 CTO, FA Software (Shanghai) Co., Ltd. 首席技术官, 上扬软件(上海)有限公司	16:00-16:25 <b>Driving Transformations of the Semiconductor Manufacturing Industry: from Automation and Digitalization to Artificial Intelligence</b> 推动半导体制造业转型: 从自动化和数字化到智能化 Jie LI 李杰 CEO, IKAS Industrial Automation 首席执行官, 深圳埃克斯工业自动化
13:55-14:20 <b>Smart Data, Intelligent Fab</b> “数”说芯程, “智”造未来 Raymond WEI 魏峥嵘 Vice President, Shanghai Huali Microelectronics Corporation (HLMC) 副总裁, 上海华力微电子有限公司	16:25-16:35 <b>Lucky Draw 观众抽奖</b>
14:20-14:45 <b>New ICT, Enable Semiconductor Digital Manufacturing</b> 新ICT, 赋能半导体数字化制造 Jishuang KUANG 邝继双 Senior Director, Chief Expert of Huawei's Smart Manufacturing Solution, HUAWEI TECHNOLOGIES CO.,LTD. 高级总监, 华为智能制造解决方案首席专家, 华为技术有限公司	

## 绿色厂务科技论坛 | Green High-Tech Facility Forum

日期 Date: 2020年6月28日, 周日 Sunday, June 28, 2020  
 时间 Time: 09:00-12:00  
 地点 Venue: 上海新国际博览中心, E7馆, 新技术舞台  
 New Tech Stage, Hall E7, Shanghai New International Expo Centre

### SPONSORS



	Moderator 主持人 Wang Yibo 王毅勃 Senior Vice President 高级副院长 The IT Electronics Eleventh Design & Research Institute Scientific and Technological Engineering Corporation Limited 信息产业电子第十一设计研究院科技工程股份有限公司	TECHNOLOGIES CO.,LTD. 华为技术有限公司, 技术总监, 数字能源高级专家
09:00-09:20	Registration 注册	
09:20-09:45	<b>Application of Sustainable Design to Water Systems of High-tech Electronics Industry</b> 电子高科技工厂可持续水系统设计 Jinge Xiao 肖劲戈 Director 总监 The IT Electronics Eleventh Design & Research Institute Scientific and Technological Engineering Corporation Limited 信息产业电子第十一设计研究院科技工程股份有限公司	10:10-10:35 <b>UPS with lithium battery for Green power solution</b> UPS锂电池系统在绿能厂房的应用 David Zheng 郑大为 R&D Director 研发总监 EATON Power Quality (Shanghai) Co., Ltd 伊顿电源(上海)有限公司
	Jiahong Zhang 张家红 技术总监 Director of Technical Deputy The IT Electronics Eleventh Design & Research Institute Scientific and Technological Engineering Corporation Limited 信息产业电子第十一设计研究院科技工程股份有限公司	10:35-11:00 Topic/演讲主题: TBD 柴永林 Eric Tsai Deputy Director Facility Department 厂务总监 TSMC China Company Limited 台积电(中国)有限公司
		11:00-11:25 <b>From Resource Saving to Circular Economy</b> 从资源节约到循环经济 Bin Wu 吴彬 Sales Director 销售总监 DAS Environmental Equipment China Ltd 戴思环保设备贸易(上海)有限公司
09:45-10:10	<b>Reliable and Energy-Saving Power Supply Solution for Manufacturing Lines</b> 可靠节能的制造产线供电解决方案 Dewen Zhou 周德文 Director of Technical Deputy, HUAWEI	11:25-11:50 <b>Key technology for deep treatment and resource recovery of waste water and waste liquid from IC industry</b> 集成电路工业废水废液深度处理与资源化关键技术 Jianglei Xiong 熊江磊 Director of an institute of Environmental Engineering Technology 环境工程技术研究所所长 China Electronics System Engineering No.2 Construction Co.,Ltd 中国电子系统工程第二建设有限公司

## 科尔摩根 — 解决苛刻的伺服性能挑战



**SafeMotion的广泛安全功能\***

STO (安全关闭转矩)	SS1 (安全停止1)
SBC/SBT (安全制动控制和制动)	SOS (安全运行停止)
SDI (安全运动方向)	SSR (安全速率范围)
SLS (安全限速)	SS2 (安全停止2)
SLP (安全限位)	SLI (安全限位增量)



AKD2G伺服驱动器



DDL高速直线电机

典型应用机型:  
FPD激光检测修复机



KBM无框直驱电机

典型应用机型:  
晶圆搬运机器人



OMP运动控制卡

典型应用机型:  
框胶机

欢迎联系我们:

电话: 400-668-2802

网址: [www.kollmorgen.cn](http://www.kollmorgen.cn)



欢迎关注官方公众号



## 新技术发布会 | New technology release conference

日期 Date: 2020年6月27日,周六 Saturday, June 27, 2020  
 时间 Time: 10:00-15:35  
 地点 Venue: 上海新国际博览中心, E7馆, 新技术舞台  
 New Tech Stage, Hall E7, Shanghai New International Expo Centre



Registration 来宾登记	MicroTec (Shanghai) Co., Ltd 苏斯中国, 键合设备技术专家
Theme: packaging and test technology 主题: 封装测试技术	12:05-13:30 Break 休息 (午餐自理)
Moderator / 主持人 Michael Chen 陈少民 Managing Director, Hina Group 汉能投资董事总经理	Theme: wafer manufacturing and materials technology 主题: 晶圆制造及材料技术
10:00-10:25 <b>The Key Domestic Equipment of IC Advanced Packaging in CETC 集成电路先进封装关键装备的国产化</b> Lezhi Ye 叶乐志 北京中电科电子装备有限公司, 技术总监	Moderator / 主持人 Richard Qian 钱立群 东电电子(上海)有限公司, 战略市场总监
10:25-10:50 TBD Jun Ma 马骏 General Manager, Shanghai Precision Measurement Semiconductor Technology, Inc 上海精测半导体技术有限公司, 总经理	13:30-13:55 TBD Yuan Lu 陆原 Technical Marketing Manager, Evatec China Ltd
10:50-11:15 <b>SiP &amp; MEMS Solutions for 5G IoT Technology 面向物联网的SiP和MEMS Sensor封装发展</b> Yupeng Xu 徐玉鹏 CTO, Forehope Electronic (Ningbo) Co., Ltd 甬矽电子(宁波)股份有限公司, 副总经理	13:55-14:20 <b>PCC Machine Module Intelligent Production Solution PCC机台模组智慧生产解决方案</b> Haijun Chen 陈海俊 Industry Manager for Smart Factory, Guangzhou MediaComm Technology Co., Ltd. 广州美凯信息技术股份有限公司, 智慧工厂行业经理
11:15-11:40 TBD Derek 张迪 Business Development Manager, ASM Pacific Technology Limited	14:20-14:45 TBD Min Zhu 朱敏 PerkinElmer, 高级产品经理
11:40-12:05 <b>Application of Collective D2W and W2W hybrid bonding for 3D IC 集成式混式键合技术在3D IC中的应用</b> Max.Cai 蔡维伽 Specialist Bonder Equipment, SUSS	14:45-15:10 <b>Cutting-edge Wire Bonding Technology for LED, Power Model and TO Packaging 最新焊线技术助力LED、功率模块, 汽车电子模块与TO封装</b> Kai Fan 范凯 Kulicke & Soffa, 资深技术方案经理
	15:10-15:35 TBD Yahui Huang 黄亚辉 NAURA, 副总裁



东莞市翰胜金属制品有限公司, 致力于为客户提供一站式散热解决方案, 可提供从热仿真, 机械设计优化, 生产, 测试及品质改进, 直至客户售后服务。为更好的服务客户, 我司配备了最新的生产设备, 热测试中心。建立了从铝挤压工厂, 冲压模房, 阳极氧化工厂, 喷涂丝印工厂到最终装配的完整产业链。

Youthen Metal Technology Co., Ltd., a one-stop-shop thermal solution provider.  
 We provide from thermal simulation, mechanical design suggestion, production, testing & quality improvement to customer service. For better servicing customers, Youthen equipped the updating production facilities, thermal testing center; built up own supply chain supporting from Aluminum extrusion, Stamping tooling shop, Anodize, Powder coating, Painting, Screen printing to Assembling.



东莞市翰胜金属制品有限公司  
Youthen Metal Technology Co., Ltd.  
 No. 1 Liantang Road, Chigang Section, Humen Town, Dong Guan, Guang Dong, China  
 广东省东莞市虎门镇赤岗社区莲塘路1号 523921  
 Tel: (+86-769) 8161 9568  
 sales@youthentec.com www.youthentec.com

## 光伏叠瓦技术与设备发展趋势研讨会

### PV Shingled Technology and Equipment Developing Trend Seminar

日期 Date: 2020年6月29日 星期一 Monday, June 29, 2020  
 时间 Time: 13:00-16:50  
 地点 Venue: 上海市浦东新区碧波路699号 上海博雅酒店碧波厅 ABC Ballroom of Parkyard Hotel Shanghai

#### SPONSORS



13:00-13:30	Registration / 注册	
13:30-13:40	<b>Welcome Remark / 欢迎致辞</b> Lung Chu 居龙 President, SEMI China SEMI 中国, 总裁	
	Moderator / 主持人 Guangchun Zhang 张光春 COO, Canadian Solar 阿特斯阳光电力集团有限公司, 高级副总裁、 首席运营官	15:10-15:40 <b>Optimization of ECA and International Standards Development</b> 导电胶应用及国际标准讨论 Qi Yue 岳琦 ECA Expert, Henkel Loctite (China) 汉高乐泰(中国)有限公司, 胶黏剂专家
13:40-14:10	<b>Discussion on Integration of PV Cells/- Modules and Shingled Technology</b> 光伏前沿电池和组件技术探讨及与叠瓦技术结合的优势 Qingtian Ma 马擎天 CTO, HUANSHENG SOLAR 环晟光伏(江苏)有限公司, 首席技术官	15:40-15:50 Break / 休息
14:10-14:40	<b>Non-destructive Cutting Technology Application in PV Modules</b> 电池无损切割在光伏组件中应用 Tao Xu 许涛 Senior Director, Canadian Solar 阿特斯阳光电力集团, 高级总监	15:50-16:20 <b>Shingled Technology Advantages on PV Modules Application and Manufacturing</b> 叠瓦组件技术应用及制造优势探讨 Peng Jin 金鹏 CTO, Seraphim Solar System 江苏赛拉弗光伏系统有限公司, 技术总监
14:40-15:10	<b>Discussion and Foresee on PV Shingled</b>	16:20-16:50 <b>Development &amp; Application of Shingling Stringer</b> 丝印叠瓦焊接机的开发与应用 Xiaoming Zhu 诸晓明 Director, Lead Intelligent Equipment 无锡先导智能装备股份有限公司, 总监

## SEMI中国光伏标准技术委员会2020春季会议

### SEMI Standards PV and PV Materials China Joint TC Chapter Spring Meeting 2020

日期 Date: 2020年6月30日 星期二 Tuesday, June 30, 2020  
 时间 Time: 08:30-17:00  
 地点 Venue: 上海市浦东新区碧波路699号 上海博雅酒店碧波厅 ABC Ballroom of Parkyard Hotel Shanghai

#### SPONSORS

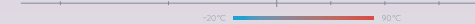


08:30 - 09:00	Registration / 注册	光伏组件工作组 •PV Equipment Task Force 光伏设备工作组 •Building Integrated Photovoltaic (BIPV) Task Force 光伏建筑一体化工作组
09:00 - 09:20	<b>Welcome Remark / 欢迎致辞</b> Lung Chu 居龙 President, SEMI China SEMI 中国, 总裁	
09:20 - 09:25	Review and Approval of Previous Meeting Minutes 审阅前次会议纪要	11:40 - 12:00 SEMI China PV TC Published Standards in 2020 Spring SEMI中国区光伏标准技术委员会2020年春季发布标准
09:25 - 09:30	SEMI Staff Report SEMI标准工作进展汇报	12:00 Lunch 午餐
09:30 - 09:50	Liaison Reports SEMI各地区联合汇报(北美、欧洲、日本、台湾)	13:30 - 13:50 Core Member Renew 核心委员申请及续任
09:50 - 10:00	Other Standards Development Organization Update 其他标准组织工作进展更新汇报	13:50 - 15:00 Ballots Cycle 1-2020 Review 2020年第1轮全球投票结果审阅
10:00 - 10:40	Task Forces Reports 工作组汇报	15:00 - 15:30 Request for Ballots in Cycle 6-2020 2020年第6轮全球投票申请
	•PV Silicon Raw Materials Task Force 光伏原材料工作组 •PV Silicon Wafer Task Force 光伏硅片工作组 •Crystalline Silicon Solar Cell Task Force 晶体硅电池片工作组 •PV Module Task Force	15:30 - 16:40 Five-Year Review 五年复审 16:40 - 16:45 New Action Items 建设性意见讨论 16:45 - 17:00 Next Meeting Date & Locale 下次会议时间和地点

# LAUDA

## LAUDA Semistats

热工的工艺恒温控制器, 温度范围从 -20 到 90 °C  
 专为半导体行业刻蚀工艺量身定制



- 低能耗, 没有压缩机和制冷剂的系统。
- 便于操作, 空间占用小, 最低限度的占用洁净室空间。
- 动态、稳定的温度控制。
- 高可靠性、低使用成本。



劳达贸易(上海)有限公司  
 LAUDA CHINA CO., LTD  
 地址: 上海市松江区民益路201号6幢2楼  
 电话: 021-64401098 · 传真: 021-64400683  
 电子邮件: info@lauda.cn · 网站: www.lauda.cn



## 2020 中国显示大会- OLED or Micro LED 2020 China Display Conference - OLED or Micro LED

日期 Date: 2020年6月27日,周六 Saturday, June 27, 2020

时间 Time: 09:30-17:30

地点 Venue: 上海浦东嘉里大酒店, 浦东厅1+2+3 Pudong Ballroom 1+2+3, Kerry Hotel Pudong, Shanghai

现场提供中英文同声传译 Chinese and English Simultaneous Interpretation will be provided

SPONSORS     

<p>Qun Yan, President China, SID 严群, SID中国区总裁</p> <p>Wenjin Xue, Vice Chairman, Nanjing Flat Panel Display Industry Association 薛文进, 南京平板显示行业协会副会长</p> <p>致辞 Opening</p> <p>09:00-09:10 Moderator: Linda, General Manager, Mega Insight Smart Manufacturing (Suzhou) Corp., Ltd. 主持人: 赵丽娜, 总经理, 达智汇智能制造(苏州)有限公司</p> <p>09:10-09:15 Xinqing Liang, Chairman, CODA 梁新清, 常务副理事长, 中国光学光电子行业协会液晶分会</p> <p>09:15-09:20 Vice President, BOE 副总裁, 京东方</p> <p>主题演讲 Invited Keynote Speakers</p> <p>09:20-09:45 NanoLEDs and microLEDs directly emitting Blue, Green and Red Pro. Lars Samuelson, Lund University and Glo AB, Lund, Sweden</p> <p>09:45-10:10 Micro-LED: The Coming Display Technology Micro-LED: 下一代显示技术 Xie Xiangwei, Director, TCL Research, Advanced Display Technology Department 谢相伟, 总监, TCL工业研究院, 新型显示技术部</p> <p>10:10-10:35 Technology Innovation and Development of Flexible AMOLED Display 柔性AMOLED显示技术创新与发展 Dr. Li Junfeng, Dean of Innovation Research Institute in Visionox Technology Co., Ltd 李俊峰, 创新研究院院长, 维信诺科技股份有限公司</p> <p>10:35-11:00 Innovative Color ePaper Development and Applications 彩色墨水屏技术创新与应用 Peter Peng, General Manager, Transcend Optonics 彭乾坤, 总经理, E Ink 川奇光电</p> <p>11:00-11:25 Boosting Your Yield: New Unique Array Testing Solutions for OLED &amp; Touch Display 助力OLED产品制造良率提升: 奥宝独有的背板及触控阵列电性测试解决方案 David Ashiri, Orbotech Pacific, Head of Marketing &amp; Application, Orbotech Pacific 奥宝科技</p> <p>11:25-11:50 GaN based Micro-LED RGB Chip Introduce a new approach to fabricate Micro-LED RGB chip on GaN with the help of nano porous and quantum dot 氮化镓Micro-LED全彩芯片</p>	<p>介绍利用纳米孔技术和量子点材料制备氮化镓基的RGB彩色Micro-LED芯片, 及这种芯片在显示应用中的特色 Shen Chen, VP, Saphlux, Inc 申辰, 副总裁, 西安赛富乐斯半导体科技有限公司</p> <p>11:50-13:30 Lunch</p> <p>13:30-13:40 Moderator: Michael Zhang, General Manager, Sineva Technology Group 主持人: 张弥, 总经理, 欣奕华科技集团</p> <p>13:40-14:05 New Coming MicroLED Display Technology to Application Market 走向应用市场化的新一代MicroLED显示技术 Hsu Chen-Ke, CTO, Sanan Optoelectronics Co., Ltd. 徐宸科, 技术总监, 三安光电股份有限公司</p> <p>14:05-14:30 Development of Organic electroluminescent materials used for AMOLED-- present and future trend AMOLED用有机光电半导体材料进展与创新探索 LI XIAOCHANG, Chairman &amp; CTO, GuanMat Optoelectronic Materials (Shenzhen) 李晓常, 董事长 &amp; CTO, 冠能光电材料(江西, 深圳)有限责任公司</p> <p>14:30-14:55 Digital Optics and Digital Modulation 数字光学与数字调制 Kenneth Tai, CEO, Jasper Display Corp 邵中和, 董事长兼执行长, 和盛光电</p> <p>14:55-15:20 GaN-on-Silicon Mini/Micro LED apply in new display GaN-on-Silicon Mini/Micro LED在新型显示中的应用 Liang Fubo, General Manager, LatticePower (Jiangxi) Corporation 梁伏波, 总经理, 晶能光电(江西)有限公司</p> <p>15:20-15:45 Micro-LED Manufacturing Solutions Gang Dong, General Manager, Toray Engineering Co., Ltd 董刚, 董事总经理, 上海华丽工程技术有限公司</p> <p>15:45-16:10 OLED Evaporation System and Key Components Development Status OLED 蒸镀设备及核心部品开发现状 Jingbo Cao, OLED SBU GM, SINEVA Co., Ltd 曹景博, OLED事业本部总经理, 欣奕华科技集团</p> <p>16:10-16:35 Mass-transfer Technology of Mini and Micro-LEDs for Display Applications Dr. Jae-Hyun Kim, KIMM, Ph.D., Head of Nano-mechanics Department 韩国机械材料研究所</p> <p>16:35-17:00 What is the next generation of display technology? 下一代的显示技术是什么? Hua Zhou, Chief Analyst, CINNO Research 周华, 首席分析师, CINNO Research</p>
---	---

## 中国国际半导体技术大会 China Semiconductor Technology International Conference

CSTIC 2020 Plenary Session:

Date: Monday, June 29, 2020

Time: 9:00-12:00am

Venue: Shanghai Ballroom 3, Kerry Hotel Pudong Shanghai. No.1388 Hua Mu Road, Pudong, Shanghai, 201204, China

CSTIC is one of the largest and the most comprehensive annual semiconductor technology conferences in China and Asia since 2000. Organized by SEMI, IMEC and IEEE-EDS, co-organized by IMECAS. CSTIC 2020 will be held on June 26-July 17, 2020 as a virtual conference. The conference will have nine symposiums covering all aspects of semiconductor technology with focus on manufacturing and advanced technology, including device design, integration, materials, and equipment, as well as emerging semiconductor technologies, circuit design, and silicon material applications.



### Distinguished Conference Keynote Speakers



Dr. Doug Yu  
Vice President, R&D  
TSMC



Dr. Ravi Mahajan  
Fellow  
Intel



Dr. Anthony Yen  
Vice President  
ASML



Dr. Sanjay Natarajan  
Vice President  
Applied Materials

### Virtual Conference:

Opening ceremony, plenary session, 9 symposium presentations, panel discussion, training and posters will be available on-line for live global participation from June 26 to July 17.

We move to online broadcast! Easier for access!  
SEMICON云官网已上线, 扫描右侧二维码免费观看会议直播!



### Sponsors:



## COMMITTEE MEMBERS

### International Advisory Committee Members



**Dr. T. C. Chen**  
Chairman  
IBM T.J. Watson  
Research Center,  
USA



**Dr. Min-Hwa Chi**  
Co-Chair  
SVP/TD, SiEn  
(Qingdao)  
Integrated Circuits Co.



**Dr. Philip Wong**  
Dr. Philip Wong  
Co-Chair  
Stanford University,  
USA



**Dr. Georg Bednorz**  
Member  
Nobel Laureate,  
Switzerland



**Dr. Qingyuan Han**  
Member  
Hans Consulting  
International, USA



**Dr. Kinam KIM**  
Member  
Samsung Institute of  
Advanced Technology,  
Korea



**Mrs. Ying Shi**  
Member  
ICMTIA, China



**Dr. Hailing Tu**  
Member  
GRNM, China



**Dr. Shichang Zou**  
Member  
Chinese Academy of  
Sciences, China



**Dr. Edward Y. Chang**  
Member  
National Chiao Tung  
University, Taiwan,  
China



**Dr. Shaojun Wei**  
Member  
Tsinghua University,  
China



**Dr. Chenming Hu**  
Member  
UC Berkeley, USA

### Steering Committee Advisors



**Mr. Lung Chu**  
President, SEMI China  
Vice President, SEMI



**Dr. Hiroshi IWai**  
Member  
Tokyo Institute of  
Technology, Japan



**Dr. Tomi T. Li**  
Member  
National Taiwan  
Central University



**Dr. David P. Huang**  
Member  
Intel, USA



**Dr. Lode Lauwers**  
Member  
IMEC, Belgium

### Conference Executive Committees



**Dr. Steve X. Liang**  
Conference Chair,  
Symp-VII Chair  
Jiangsu Changjiang  
Electronics Technology



**Dr. Qinghuang Lin**  
Symp-VIII Chair, Conference  
Executive Co-Chair  
Lam Research Corporation,  
USA



**Dr. Ru Huang**  
Symp-I Chair,  
Conference Co-Chair  
Peking University,  
China



**Dr. Cor Claeys**  
Conference Co-Chair  
and Award Selection  
Chair  
KU Leuven, Belgium



**Dr. Hanming Wu**  
Conference Co-Chair  
Zhejiang University,  
China



**Dr. Kafai Lai**  
Symp-II Chair  
IBM T.J. Watson  
Research Center,  
USA



**Dr. Ying Zhang**  
Symp-III Chair  
Naura, USA



**Dr. Beichao Zhang**  
Symp-IV Chair  
HFC Semiconductor,  
China



**Dr. Xinping Qu**  
Symp-V Chair  
Fudan University,  
China



**Dr. Peilin Song**  
Symp-VI Chair,  
Conference Co-Chair,  
Publicity Chair  
IBM T.J. Watson Research  
Center, USA



**Dr. Wenjian Yu**  
Symp-IX Chair  
Tsinghua University,  
China



**Dr. Hsiang-Lan Lung**  
Poster Chair  
Macronix International  
Ltd., Taiwan, China

### Partial List of Confirmed CSTIC 2020 Invited Speakers



**Dr. Tak H. Ning**  
Fellow,  
IBM



**Dr. Jean-Charles Barbé**  
Chief Scientist,  
CEA-LETI



**Dr. Huiming Bu**  
Director,  
IBM



**Prof. Stacey F. Bent**  
Professor,  
Stanford University



**Dr. AbdelKarim Mercha**  
Technical Director,  
IMEC



**Prof. Shawn Blanton**  
Professor, Carnegie Mellon  
University



**Dr. Wei Fang**  
Senior Director,  
ASML



**Dr. Jonathan Reid**  
Fellow,  
Lam Research



**Dr. Hu Chuan**  
Chief Expert,  
Guangdong Academy  
of Sciences



**Dr. Bill Bottoms**  
Chairman & CEO,  
3MTS



**Prof. Vijaykrishnan  
Narayanan**  
Distinguished Professor,  
Pennsylvania State  
University



**Prof. Hidetoshi Onodera**  
Professor,  
Kyoto University

### Workforce Development Training Courses

Online Conference  
June 28-July 17, 2020

- Advanced Memory Technologies: MRAM
- Semiconductor Testing Solutions in the Trend of 5G and AI
- Advanced Memory Technologies: ePCM/3D-PCM
- Heterogeneous Integration and Advanced Packaging
- IC Reliability Tests for 5G Applications

### CSTIC 2020 Registration (RMB)

	Price(RMB)	Explain
Contributors with paper publication on IEEE	1800	Join the live meeting, get conference materials (Electronic proceedings) and communicate with >400 speakers.
Normal registration	900	Join the live meeting, get conference materials (Electronic proceedings) and communicate with >400 speakers.
Free registered attendees	0	Only can watch all the record on web, but with no right and privilege to chat with speakers.
Workforce Development Training Courses	500	Enjoy the benefit to download training PPTs and communicate with speakers.

### CSTIC 2021 Call for Papers

Date: March 14-15, 2021

Abstract Submissions Deadline: November 15, 2020

Topics to be addressed at CSTIC 2021 include, but are not limited to the following:  
 Symposium I: Device Engineering and Memory Technology  
 Symposium II: Lithography and Patterning  
 Symposium III: Dry & Wet Etch and Cleaning  
 Symposium IV: Thin Film, Plating and Process Integration  
 Symposium V: CMP and Post-Polish Cleaning  
 Symposium VI: Metrology, Reliability and Testing  
 Symposium VII: Packaging and Assembly  
 Symposium VIII: MEMS, Sensors and Emerging Semiconductor Technologies  
 Symposium IX: Design and Automation of Circuits and Systems



## 2020 Program and Events At a Glance 2020 大会活动一览

● Offline Conference 现场会议 ● Live/Online Conference 直播/线上会议

Saturday June 27 周六 6月27日		
09:30-17:30	2020 China Display Conference - OLED or Micro LED 2020 中国显示大会 - OLED or Micro LED	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
12:30-16:30	Grand Opening Keynote 开幕主题演讲	Kerry Hotel Pudong, Shanghai / Live Conference 上海浦东嘉里大酒店 / 直播会议
10:30-16:00	New Technology Release Conference 新技术发布会	Shanghai New International Expo Centre 上海新国际博览中心
10:00-16:00	SEMI Industry @ Cloud SEMI 产业云论坛	Online Conference 线上会议
17:30-19:30	China IC Night President Reception (By Invitation)	
Sunday June 28 周日 6月28日		
09:00-16:45	SIIP China: SEMI Innovation And Investment Forum SIIP China: SEMI 产业创新投融资论坛	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
09:00-12:00	Advanced IC Manufacturing Forum 先进晶圆制造论坛	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
13:00-16:45	Advanced Packaging Forum 先进封装论坛	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
09:00-17:00	Power & Compound Semiconductor International Forum 功率及化合物半导体国际论坛	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
09:30-12:00	Green High-Tech Facility Forum 绿色厂房科技论坛	Shanghai New International Expo Centre 上海新国际博览中心
13:00-16:45	Smart Manufacturing Forum 智能制造论坛	Shanghai New International Expo Centre 上海新国际博览中心
10:00-16:00	SEMI Industry @ Cloud SEMI 产业云论坛	Online Conference 线上会议
All Day	Workforce Development Training Advanced Memory Technologies先进存储技术: MRAM	Online Conference 线上会议
All Day	Workforce Development Training Advanced Memory Technologies先进存储技术: ePCM/3D-PCM	Online Conference 线上会议
All Day	Workforce Development Training Semiconductor Testing Solutions in the Trend of 5G and AI应用的芯片测试	Online Conference 线上会议
All Day	Workforce Development Training Heterogeneous Integration and Advanced Packaging异构集成与先进封装	Online Conference 线上会议
All Day	Workforce Development Training IC Reliability Tests for 5G Applications 5G应用IC的可靠性	Online Conference 线上会议
Monday June 29 周一 6月29日		
08:45-12:00	China Semiconductor Technology International Conference - Plenary Session CSTIC 中国国际半导体技术大会 - 开幕演讲	Kerry Hotel Pudong, Shanghai / Live Conference 上海浦东嘉里大酒店 / 直播会议
09:00-12:00	Memory Strategic Forum 存储器发展论坛	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
09:00-17:00	Power & Compound Semiconductor International Forum 功率及化合物半导体国际论坛	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
09:30-12:30	SEMI Workforce CXO Talent Forum SEMI 中国英才计划领袖峰会	Shanghai New International Expo Centre / Live Conference 上海新国际博览中心 / 直播会议
13:00-17:00	SEMI PV Shingled Technology and Equipment Developing Trend Seminar SEMI 光伏叠瓦技术与设备发展趋势研讨会	Parkyard Hotel, Shanghai 上海博雅酒店
09:00-17:00	SEMI MSIG Smart Mobility Forum SEMI MSIG 智能电动汽车芯片论坛	Live Conference 直播会议
10:00-16:00	SEMI Industry @ Cloud SEMI 产业云论坛	Online Conference 线上会议
Tuesday June 30 周二 6月30日		
08:30-17:00	SEMI Standards PV and PV Materials China Joint TC Chapter Spring Meeting 2020 SEMI 中国光伏标准技术委员会2020春季会议	Parkyard Hotel, Shanghai 上海博雅酒店
10:00-19:30	SEMI Golf Tournament (By invitation) "芯球会" SEMICON CHINA 高尔夫精英赛 (特邀)	Shanghai Sheshan Interational Golf Club 上海佘山国际高尔夫俱乐部
Friday June 26 - Friday July 17 周五 6月26日 - 周五 7月17日		
All Day	China Semiconductor Technology International Conference CSTIC 中国国际半导体技术大会	Online Conference 线上会议

# FLOOR PLAN

## 展馆平面图 E1





# FLOOR PLAN

## 展馆平面图 E2



# FLOOR PLAN

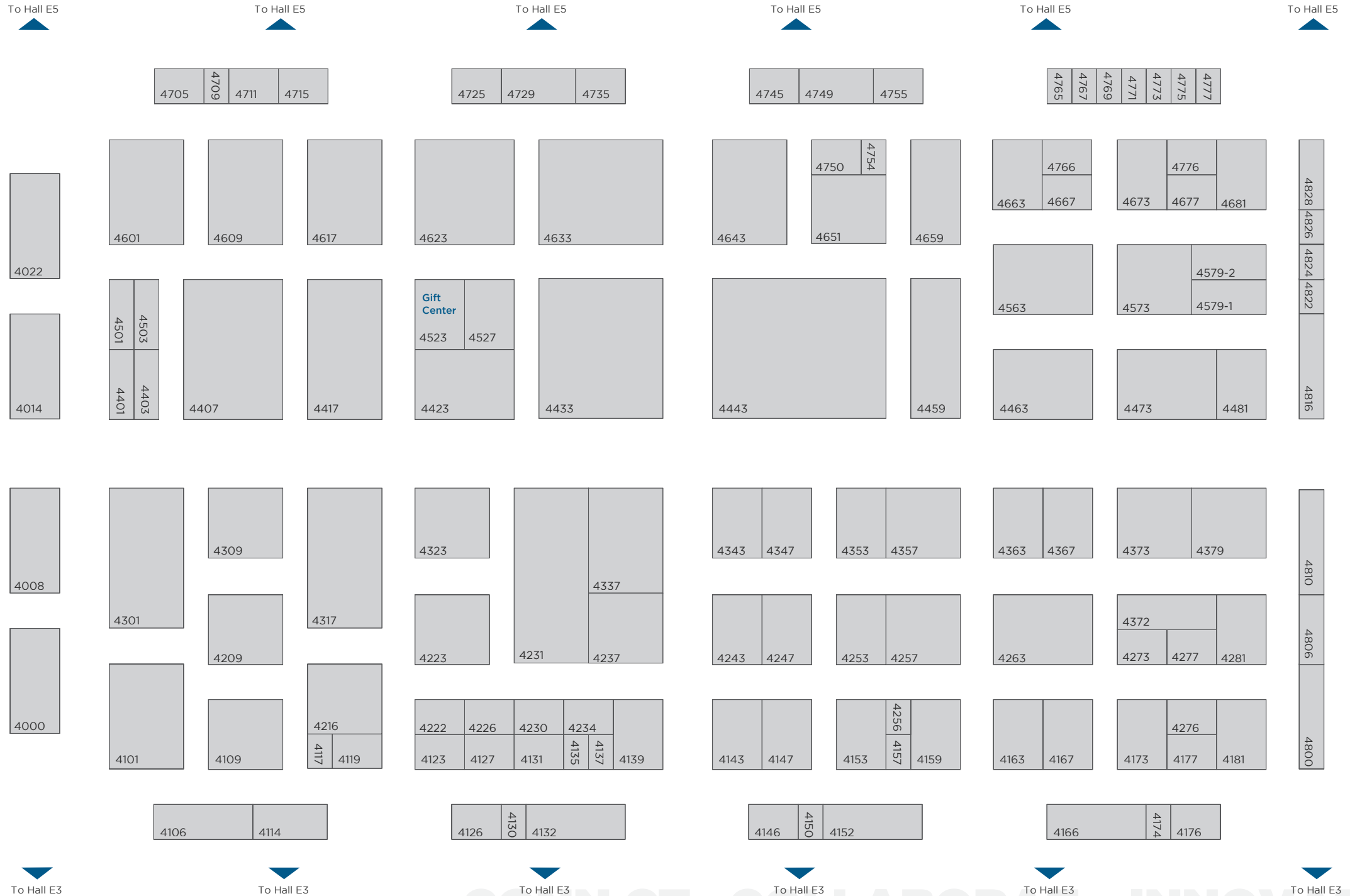
## 展馆平面图 E3





# FLOOR PLAN

## 展馆平面图 E4



# FLOOR PLAN

## 展馆平面图 E5





# FLOOR PLAN

## 展馆平面图 E6





## SEMICON 2020 Exhibitors List

Company	Booth	Hall
A ABM, Inc	2129	E2
Accelerated Printed Circuit Board Co.,Ltd	2579	E2
AccoTEST BU. of Beijing Huafeng Test & Control Co.,Ltd.	2119	E2
Accuracy Assembly Automation Co., Ltd	6000	E6
Achilles Corporation	7234	E7
ACM Research (Shanghai), Inc.	5223	E5
ACOULAB Co., Ltd.	6269	E6
Adamant Namiki Precision Jewel Co., Ltd.	6710	E6
ADEKA (China) Co.,Ltd	7259	E7
Adelis Associates Pte Ltd.	4705	E4
ADTEC Plasma Technology Co.,Ltd	3133	E3
Advanced Dicing Technologies Ltd	6014	E6
Advanced Energy Industries. Inc., Shanghai	2373	E2
Advanced Global Alliance Limited	3667	E3
Advanced Micro-Fabrication Equipment Inc. China	2301	E2
Advanced Technology & Materials Co.,Ltd	2211	E2
AFRISO Measurement&Control Technology (Suzhou) Co., Ltd	2671	E2
AI Technology, Inc.	2626	E2
AIR LIQUIDE China Holding Co., Ltd.	5008	E5
Air Products and Chemicals (China)	2317	E2
Akribis Systems (Shanghai) Co.,Ltd	5473	E5
All Ring Tech Co., Ltd.	6808	E6
Allied Supreme (Jia Xing) Corp.	4816	E4
Alltech Electronic Technology Co.Ltd	6254	E6
Allwin21 Corporation	4735	E4
Amaya Co., Ltd.	5226	E5
American Tec Co. Ltd	4163	E4
AMFLO Fluid System & Components Co., Ltd.	1519	E1
Anhui Argosun New Electronic Material Co., Ltd	2267	E2
Anhui Botai Electronic Materials Co., Ltd	5152	E5
Anhui Dahua Semiconductor Technology Co., Ltd	2451	E2
AnHui EcoSys Automation Solutions Co., Ltd	7634	E7
Anhui Sine Microelectronics Co., Ltd.	5423-5	E5
Anton Paar	7628	E7
ANZ Company	1326	E1
Applied Seals Co., Ltd. (Taiwan)	4123	E4
APS Materials, Inc.	7352	E7
Asahi Diamond Industrial Co., Ltd.	7619	E7
ASFLOW Co., Ltd.	2174	E2
ASM Pacific Technology Limited	3235	E3
ASML	5639	E5
ASUZAC Inc.	6637	E6
ATC Co., Ltd.	7617	E7
ATI Korea Co., Ltd.	5166	E5
Atlas Technology Corporation	3255	E3
Atotech (China) Chemicals Ltd.	5317	E5
Baoding North Special Gas Co., Ltd	7735	E7
Baud Technology Shanghai Co., Ltd.	4417	E4
BCnC CO., LTD	7481	E7
Be First Technology Co., Ltd.	3257	E3
Beijing Asia Science & Technology Co., Ltd	2409	E2
BEIJING BEIYI WOOSUNG VACUUM TECHNOLOGY CO., LTD	6234	E6
Beijing CGB Technology Co., Ltd	2543	E2
Beijing CR Technology Co., Ltd.	3126	E3
Beijing Dongzhou Technology Co.,Ltd	2355	E2
Beijing Doublink Solders Co., Ltd.	4153	E4
Beijing E-Town International Investment&Development Co., Ltd	1433	E1
BeiJing E-Town Semiconductor Technology Co., LTD	5022	E5
Beijing Gerchin Science and Technology Ltd.	7636	E7
Beijing Grish Hitech Co., Ltd.	2233	E2
Beijing Heqi Precision Technology Inc.	4253	E4
Beijing Jingyi Automation Equipment Co., Ltd	7439	E7
Beijing Jingyuntong Technology Co., Ltd	6223	E6
Beijing Kaide Quartz Corporation	4000	E4
Beijing Konglian Science & Tehnology Co., Ltd	6134	E6
Beijing Longsun Technology Co., Ltd.	2473	E2
<b>Beijing NAURA Microelectronics Equipment Co.,Ltd.3433</b>	<b>E3</b>	
BeiJing Reje Automation Co., Ltd	1263	E1
Beijing Sinodynetest Science&Technology Co.,Ltd	4247	E4
Beijing TSD Equipment Co., Ltd	2135	E2
Beijing Xiantec Technology Ltd.	1617	E1
Beijing Zhongke Holding Co., Ltd	6230	E6
BENEQ OY	2726	E2
Bengbu Bright Semiconductor Co., Ltd	1537	E1

Company	Booth	Hall
Besi (BE Semiconductor Industries N.V.)	3617	E3
Bestac Advanced Material Co., Ltd	2812	E2
Better Pure Material Co.,Ltd	4273	E4
BISTEL,Inc	2704	E2
BMT Co., Ltd.	4651	E4
Bonotec Electronic Materials Co., Ltd.	6615	E6
Brooks Automation, Inc.	1623	E1
Bruker (Beijing) Scientific Technology Co., Ltd	6243	E6
Bueno Technology Co., Ltd.	1527	E1
Bukwang Tech Co., Ltd.	7219	E7
C. H. Robinson Freight Services (China) Ltd.	7249	E7
Camtek HK Ltd.	3363	E3
Carl Zeiss Far East Co., Ltd.	1619	E1
CETC Electronics Equipment Group Co., LTD	3463	E3
Changchun Changguang Yuanchen Microelectronic Technology Co., Ltd.	5711	E5
ChangChun GuangHua Micro-Electronics Equipment Engineering Center Co., Ltd.	6315	E6
Changzhou Changyao	5677	E5
Changzhou Mingsel Robot Technology Co., Ltd	7608	E7
Changzhou Ruize Microelectronics Co., Ltd	2654	E2
Changzhou S.C Exact Equipment Co.,Ltd	7816	E7
Chart Automation System Co., Ltd	4463	E4
Cheng Tay Heater & Instrument Co., Ltd	3711	E3
Chengdu Apex New Materials Co., Ltd	1751	E1
Chengdu ArTech Specialite Graphite Co., Ltd	7773	E7
Chengdu Laipu Science & Technology Co., Ltd	1643	E1
Chengdu Shangming Industrial Co., Ltd	3804	E3
Chengdu Wattisne Electronic Technology Co.,Ltd	6780	E6
Chengdu Yeheng Electronic Co., Ltd	3170	E3
China Electronic Market	7768	E7
China Electronic Production Equipment Industry Association	6434	E6
China Electronics System Engineering No.2 Construction Co.,Ltd	7101	E7
China Fortune Land Development Co., Ltd.	4323	E4
China Integrated Circuit	7766	E7
China Semiconductor Industry Association	7824	E7
CHIPMORE Technology Corporation Limited	5601	E5
Chongqing ZhenBao Industry Co., Ltd	7129	E7
CHUKOH Chemical (Shanghai) Trading., Ltd	6678	E6
Chung King Enterprise Co.,Ltd	4237	E4
Cica-Huntek Chemical Technology Taiwan Co., Ltd.	3481	E3
Cimetrix Incorporated	2354	E2
CKD Corporation	2511	E2
Clean Factomation Inc.	6175	E6
"Compound Semiconductor China"/"Silicon Semiconductor China"	7235	E7
Conax Technologies	3350	E3
Corad Technology, Ltd.	4822	E4
Crest Systems (Suzhou) Co., Ltd.	4749	E4
CSE Co., Ltd.	4709	E4
CTT China Technology Trading GmbH	2669	E2
CXsemi Company Limited	5769	E5
Cycad Century Science&Technology Ltd.	2455	E2
Dalian High Purity Chemical Co., LTD	5816	E5
Dalian Jafeng Automation Co.,Ltd	3275	E3
Dalian Shungji Technology Industry Co., Ltd	7515-1	E7
Dalian Zhongding Chemicals Co., Ltd.	6519	E6
Dandong Aolong Radiative Instrument Group Co.,Ltd	6126	E6
Dandong Liaodong Radioactive Instrument Co., Ltd	6132	E6
Dandong Xin Dongfang Crystal Instrument Co., Ltd	1022	E1
DAS Environmental Expert GmbH	2419	E2
Denair Energy-Saving Technology (Shanghai) Stock Co., Ltd	6130	E6
DISCO HI-TEC CHINA CO., LTD.	3401	E3
DK-Lok Corporation	2458	E2
Do-FluoRIDE CHEMICALS Co., LTD	5643	E5
Dong Rong Electronics Co., Ltd.	7413	E7
Dong Rong Electronics Co., Ltd.	4177	E4
Dongfang Jingyuan Electron Limited	7136	E7
Dongguan Wintime Electronic Co., Ltd	4114	E4
Dongjin Semichem Co., Ltd.	4609	E4
Dongwoo Fine-Chem Co., Ltd.	7601	E7
Dou Yee Enterprises (S) Pte Ltd	4601	E4
DR. JOHANNES HEIDENHAIN (CHINA) Co., Ltd.	2343	E2
DS Fibertech Corporation	2507	E2
Dwyer Instruments HK, Ltd.	2647	E2

## SEMICON 2020 Exhibitors List

Company	Booth	Hall
Dymek Company Ltd.	2227	E2
E and R Engineering Corporation	7423	E7
EAG laboratories	4234	E4
ebm-papst Ventilator (Shanghai) Co., Ltd.	7748	E7
ECI Technology Inc.	2263	E2
EDA Industries S.p.a.	1306	E1
Effectek Technologies(Shenzhen) Co.,Ltd	3266	E3
Elemental Scientific, Inc.	4119	E4
ELIONIX INC.	4824	E4
Enam Optoelectronic Material Co., Ltd	6627	E6
Engis (Hong Kong) Ltd	2575	E2
Enplas Niching Suzhou Co.,Ltd	7166	E7
Ensinger, Inc.	4401	E4
Entegris (Shanghai) Microelectronics Trading Co., Ltd.	5201	E5
EO Technics Co., Ltd.	3651	E3
ePAK International, Inc.	3812	E3
EQ Tech Plus Co., Ltd	4117	E4
ERS Electronic GmbH	3109	E3
ESCS Co., Ltd-Taiwan Branch	6263	E6
Eta Research Ltd.	6754	E6
E-Tech Solution Co., Ltd.	4677	E4
Europe-China Electronic Materials Co., Ltd	5649	E5
EV Group (EVG)	2423	E2
Evatec AG	3243	E3
Ever Team International Corp.	3319	E3
Everlight Chemical Industrial Corporation	4243	E4
Exis-Tech Sdn Bhd	5567	E5
F&k Delvotec (Shanghai) Co., Ltd	3269	E3
Faeth GmbH	7428	E7
Fantron Technologies (Shanghai) Co. Ltd.	6311	E6
FCT (Tangshan) New Material Co., Ltd	6246	E6
FEI Hong Kong Company Limited	3369	E3
Fine Silicon Manufacturing (Shanghai) Ltd.	6734	E6
Finetest Co.,Ltd	3219	E3
First Technology China Ltd.	3857	E3
FISCHER INSTRUMENTATION LTD	2008	E2
FITOK GmbH	6669	E6
Fittech Co., Ltd	5101	E5
Flowell Corporation	5106	E5
FNS, Inc.	7714	E7
Forehope Electronic (Ningbo) Co., Ltd	5535	E5
FTDevice Technology(Suzhou) Co.,Ltd	1733	E1
Fudong Quartz LLC	4755	E4
Fugen Co., Ltd	6539	E6
Fujian Deer Technology Company Ltd	5156	E5
Fujian Jiuce Gases Group Co., Ltd	5343	E5
Fujian Yongjing Technology Co., Ltd.	4765	E4
Fujikin Incorporated	3000	E3
Fujinson Technology Limited	7443	E7
Fuzhou Palead Electronics Technology Co., Ltd	7639	E7
Galaxy Technology Development Company	1186	E1
Gastron Co., Ltd.	6709	E6
Gemu Valves (China) Co., Ltd.	2519	E2
German Federal Ministry of Economics and Technology	2863	E2
GI Tech Co., Ltd	6022	E6
GLOBAL ZEUS	7301	E7
GLOBAL ZEUS : J.E.T. Co., Ltd	7301	E7
GrandIT Co., Ltd	5163	E5
Grandmake Technology Ltd	7253	E7
Great Mandarin Technology Co.,Ltd	1158	E1
Grikin Advanced Materials Co., Ltd.	6415	E6
GTA MATERIAL CO., LTD.	4579-2	E4
GTA Semiconductor Co.,Ltd	5401	E5
Guang Dong SUOREC Technology Co., Ltd	2243	E2
Guang'an Lizheng Metal Co.,LTD	6756	E6
Guangdong AD Intelligent Equipment Co., Ltd.	3262	E3
Guangdong TJ Electronic System Engineering CO.,LTD	6746	E6
Guangxi Guixin Semiconductor Technology Co., Ltd.	5523	E5
Gudeng Precision Industrial Co., Ltd.	4106	E4
Gui Lin LDAB Semiconductor Equipment Co.,Ltd	7307	E7
Haiyan Klean Tubing Co., Ltd	6526	E6
Hakuto Enterprises (Shanghai) Ltd.	1211	E1
Hamai Co., Ltd.	2143	E2
HAMAMATSU PHOTONICS K.K.	2163	E2
Ham-let (Israel-Canada) Ltd.	1633	E1
Hangzhou Anow Microfiltration Co., Ltd	4281	E4
HangZhou Changchuan Technology Co.,Ltd	5129	E5

Company	Booth	Hall
Hangzhou Cobetter Filtration Equipment Co., Ltd.	2401	E2
Hangzhou Daotian Vacuum Equipment Co., Ltd.	1746	E1
Hangzhou Daily Filtration Equipment Co., Ltd.	1710	E1
Hangzhou Deefine Filtration Technology Co., Ltd	7126	E7
Hangzhou Pro-chan Semiconductor Technology Co., Ltd	7531	E7
Hanking Electronics (Liaoning) Co., Ltd	3207	E3
HANMI Semiconductor	3633	E3
Han's Laser Technology Industry Group Co., Ltd	6363	E6
Han's Photoelectric Equipment Co.,Ltd.	3579	E3
Hanyang ENG Co., Ltd.	7401	E7
Harmonic Drive Systems (Shanghai) Co., Ltd	4826	E4
Harvest Electronic Technology Co., Ltd	4174	E4
Hawk Filtration Technology (Shanghai) Co.,Ltd	6274	E6
Hearts Technology Corp.	4754	E4
Hefei Chip Foundation Micro-Electronics Equipment Co., Ltd	7313	E7
Hefei ImagEx Electronics Technology Co., Ltd.	5481	E5
Hefei TBSTest Technologies Co., LTD	4139	E4
Henan Guoxi Ultrapure New Material Co., Ltd	5804	E5
Henan Keen Superhard Materials Technology Co., Ltd.	5846	E6
HeNan Union Precision Material Corp. Ltd.	2116	E2
Henkel Loctite (China) Co., Ltd.	5117	E5
Heraeus Quarzglas GmbH & Co. KG (Heraeus Conamic) : Heraeus Materials Technology Shanghai Ltd.	7106	E7
Heraeus Shin-Etsu Quartz China Inc.	3014	E3
Hermes-Epitek Corp.	3379	E3
Hero Fair Limited	5127	E5
Hitachi Power Solutions Co.,Ltd.	4317	E4
Hiwin Mikrosystem Corp.	1612	E1
Hokuriku Machinery Trading (Suzhou) Co., Ltd	7745	E7
Honda Electronics Co., Ltd.	5605	E5
Howell Automation and Control Solutions (China) Co.,Ltd	7332	E7
Hongke Technology Co., Ltd	2501	E2
HORIBA, Ltd.	7407	E7
Hornng Terng Automation Co., Ltd.	7316	E7
HPWK Machine	7630	E7
Hsiung Mu Enterprise Co., Ltd	7463	E7
ht tech	5355	E5
Huate Gas Co.,Ltd	5611	E5
Huawei Technologies Co.,Ltd	5181	E5
Hubei Dinghui Microelectronics Materials Co., Ltd	5253	E5
Hubei Sinophorus Electronic Materials Co., Ltd.	2711	E2
HUNAN STCERA CO.,LTD	7137	E7
HUZHOU BESTLOK Fluid Equipment Ltd	6769	E6
Huzhou Dong ke Electron Quartz Co., Ltd.	7155	E7
HUZHOU OPAL QUARTZ TECH CO., LTD	5112	E5
Huzhou Veeed Opto-Technology Co., Ltd	7174	E7
Hwashed Technology (Shanghai) Co., Ltd	5273	E5
Hwatsing Technology Co., Ltd	7623	E7
Hwyng Technology Limited	3136	E3
lander Automation	2133	E2
IBIDEN ELECTRONICS (SHANGHAI) CO.,LTD	4216	E4
i-Bot Technology Inc.	6571	E6
ICAS TESTING TECHNOLOGY SERVICE (SHANGHAI) CO.,LTD	2249	E2
GLOBAL ZEUS	6643	E6
ICS Technology Co., Ltd.	4230	E4
Industrial Vision Technology (S) Pte Ltd.	7306	E7
INFICON Limited	5776	E5
Inner Mongolia Ojing Science&Technology Co., Ltd	7623	E7
Inno Global Inc.	7559	E7
InnoLas Semiconductor GmbH	4443	E4
Innores Co., Ltd.	6231	E6
Institute of Microelectronics of Chinese Academy of Sciences	4126	E4
Institute Of Optics And Electronics Chinese Academy Of Sciences	5423-2	E5
INTEKPLUS Co., Ltd.	4123	E4
InventChip Technology Co.,Ltd	5581	E5
IS Sealing Solutions Co.,Ltd	7251	E7
ISC Co., Ltd	3705	E3
IVT Tech Co., Ltd	6411	E6
Iwaki Pumps (Shanghai) Co., Ltd	4725	E4
JAPAN CREATE Co., Ltd.	6653	E6
Japan Electronic Materials Corporation	5014	E5
JAPAN FINE CERAMICS CO.,LTD (JFC)		
JCET Group Co., Ltd.		



## SEMICON 2020 Exhibitors List

Company	Booth Hall
JEL CORPORATION	1263 E1
JEOL Ltd.	2735 E2
JHT Design Co., Ltd.	7749 E7
Jiangsu Advanced Material Technology & Engineering Inc.	6163 E6
Jiangsu Asia Electronics Technology Co., Ltd.	7501 E7
Jiangsu Aulfirst Material Technology Co., Ltd	2769 E2
Jiangsu Eastone Technology Co., Ltd	7022 E7
Jiangsu Hengtong Intelligent Technology Co., Ltd	5751 E5
Jiangsu Hongwei Quartz Technology Co., Ltd	7317 E7
Jiangsu JEIL E&S Co., Ltd	6674 E6
Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd.	4209 E4
Jiangsu Leadmicro Nano Technology Co.,Ltd	2123 E2
Jiangsu LEBO Science Instrument Co., Ltd	6112 E6
Jiangsu MNT Micro and Nano tech Co.,LTD	3134 E3
Jiangsu Nata Opto-electronic Material Co., Ltd.	2111 E2
Jiangsu OKFLON Sealing Technology Co., Ltd	4503 E4
Jiangsu Pacific Quartz Co.,Ltd.	5235 E5
Jiangsu sovalue Semiconductors Technology Company	7648 E7
Jiangsu Sujing Group Co.,Ltd	6215 E6
Jiangsu Taizhi Technology Co., Ltd	6714 E6
Jiangsu Xinhua Semiconductor Material Technology Co., Ltd	2201 E2
Jiangsu Yoke Technology Co., Ltd	3101 E3
Jiangyin Chemical Reagent Factory Co., Ltd	2311 E2
Jiangyin Jianghua Microelectronic Materials Co., Ltd	5147 E5
Jiangyin Runma Electronic Material Co., Ltd	5259 E5
Jiaxing Kemin Electronic Equipment Technology Co.,Ltd	6768 E6
Jilin Huiheng Electronic Technology Co., Ltd	6235 E6
Jinan Ligan Electronics Technology Co., Ltd	6336 E6
JinZhou East Quartz Material Co., Ltd.	4373 E4
Jinzhou Youxin Quartz Technology Co., LTD	5748 E5
Jipai Fluid Control Technology(Jiangsu) Co.,LTD	6159 E6
JRS	1656 E1
JSR Corporation	5263 E5
JULABO GmbH	2768 E2
Jung Sung Tech Co.,Ltd.	2110 E2
JUSUNG Engineering Co., Ltd.	5651 E5
JYE YEU ENTERPRISE Co., Ltd	2653 E2
<b>K</b> Kaijo Corporation	6251 E6
Kaiming Electronic Technology (Shanghai) Co., Ltd	7149 E7
Kanematsu Corporation	1824 E1
Kanken Techno Co., Ltd.	7139 E7
KANOMAX JAPAN INC.	7233 E7
Kashiyama Industries,LTD.	4347 E4
KCC Corporation	7417 E7
KDF	6515 E6
Kempur Microelectronics, Inc.	5347 E5
Kesite Instruments (Dandong) Co., Ltd.	6114 E6
KESM INDUSTRIES(TIANJIN) CO.,LTD	5725 E5
King Virtue Electron Co., Ltd	3601-1 E3
KINGSEMI CO., LTD	3301 E3
Kingyoun Enterprises Co., Ltd.	2765 E2
KITA Manufacturing Co., Ltd.	3246 E3
KITZ SCT CORPORATION	2022 E2
KLA Corporation	5705 E5
KNG-TECH (SHANGHAI) CO., LTD	5170 E5
Kojima Instruments Shanghai Inc.	1749 E1
KOTRA (Korea Trade-Investment Promotion Agency)	6523 E6
KOTRA (Korea Trade-Investment Promotion Agency)	6527 E6
KOTRA (Korea Trade-Investment Promotion Agency)	6531 E6
KOTRA (Korea Trade-Investment Promotion Agency)	6547 E6
KOTRA (Korea Trade-Investment Promotion Agency)	6622 E6
KSM Co., Ltd.	1509 E1
Kulicke & Soffa Pte Ltd	3417 E3
Kun Shan CEMA Technology Corporation Ltd	7312 E7
KUNSHAN APRIS TECHNOLOGIES CO.,LTD	6271 E6
KUNSHAN BEST PACKAGE MATERIAL CO., LTD.	2628 E2
Kunshan Guoli Electronic Technology Co.,Ltd	6579 E6
Kunshan Jinmeichuang Machinery Co., Ltd.	6335 E6
Kunshan Suyang Precision Mould Co., Ltd	1657 E1
Kunshan You Fu Precision Machine Co., Ltd	3116 E3
Kunshan Zhimao Technology Equipment Co., Ltd.	3749 E3
Kurt Lesker (Shanghai) Trading Company	1513 E1
KYKY Technology Co., Ltd	1647 E1
<b>L</b> Leeno Industrial Inc.	5563 E5

Company	Booth Hall
Legend Electronic Tech Co., Ltd	3131 E3
Letry (Shanghai) Clean Technology Co., Ltd.	6149 E6
Linde Lienhwa	2429 E2
Linggas (Tianjin), Limited.	4226 E4
Linkgenesis Co., Ltd.	6804 E6
Lintec Advanced Technologies (Shanghai) Inc.	4433 E4
Loranger International Corporation	3623-2 E3
LPE (Shanghai) International Trading Co., Ltd.	2219 E2
LPKF Laser & Electronics AG	2770 E2
Luva System Inc.	2674 E2
<b>M</b> M+ electronic Equipment	6713 E6
Mabuchi Spectra & Technology (Suzhou) Trading Inc.	7163 E7
Macquarie Electronics USA Inc.	7553 E7
Marketech International Corp.	6601 E6
Marposs (Shanghai) Trading Ltd	4222 E4
Maruyama Manufacturing Corporation	2648 E2
Matfron (Shanghai) Semiconductor Technology Co., Ltd	3279 E3
Maxone Semiconductor (Suzhou) Co.,Ltd	3143 E3
MCL Electronic Materials, Ltd.	5673 E5
MCRT Micro CleanRoom Technology GmbH	2766 E2
memsstar Limited	2263 E2
Merck Holding (China) Co.,Ltd	5323 E5
Micro-Mechanics (Su Zhou)	3755 E3
Micro-Power (H.K.) Semiconductor Ltd.	1627 E1
Micro-Power Scientific (H.K.) Co. Ltd.	3175 E3
Millennium Microtech (Shanghai) Co., Ltd	5443 E5
Miragas Co., Ltd.	6633 E6
MIT Semiconductor (Tianjin) Co., Ltd	7323 E7
Mitsubishi Chemical Corporation	4363 E4
MK Trading (Shanghai) Co.,Ltd	6563 E6
MONOCRYSTAL	4353 E4
Moov Technologies Inc.	1304 E1
Motic China Group Co., Ltd.	6762 E6
MPI Corporation	3166 E3
Msscrops (Nanjing) Co., Ltd	7356 E7
MUJIN ELECTRONICS Co., Ltd.	4478 E4
Mykron Microelectronics Co., Ltd.	3800 E3
<b>N</b> Nanjing Advanced Semi-conductor Technology Co.,Ltd	6639 E6
Nanjing Guosheng Electronics Co., Ltd	5143 E5
Nanjing PinWei Intelligence Technology Co.,Ltd	5729 E5
Nanjing Sanchao Advanced Materials Co., Ltd.	5000 E5
NanoVis Electronics Technologies (China) Limited	5301 E5
Napson Corporation	1423 E1
National Instruments	1709 E1
National Silicon Industry Group	5543 E5
New Fast Technology Co., Ltd.	1172 E1
Next Test Solution(NTS)	7567 E7
NEXTIN Inc.	6543 E6
Nextool Technology Co.,Ltd	4309 E4
Nidec SV TCL	7342 E7
Nidec-Read Corp.	7346 E7
NIFLON MACROMOLECULAR MATERIAL (SH)CO.,LTD	5110 E5
NIKON CORPORATION	3601-2 E3
Nikon Precision Shanghai Co., Ltd.	3601-3 E3
Ningbo Allsemi Microelectronics Equipment Co., Ltd	6219 E6
Ningbo Baosi Energy Equipment Co., Ltd	2756 E2
Nippon Pulse Motor Trading Co., Ltd.(NDS)	4343 E4
NISHIMURA CHEMITECH CO.,LTD	3244 E3
NISSIN ALLIS ION EQUIPMENT (SHANGHAI) CO., LTD	2132 E2
Nordson Advanced Technology	3451 E3
Norker Filter (Suzhou) Co., Ltd	6179 E6
Nova Measuring Instruments Ltd.	5301 E5
Nowes Technology Corporation Limited	4132 E4
NTM Technology Co., Ltd	6611 E6
NTS (Suzhou) Co., Ltd.	6371 E6
<b>O</b> OKins Electronics	5477 E5
OKins Electronics	5576 E5
OKY	2257 E2
Olympus (China) Co., Ltd	2619 E2
Omnivision Group	5423-1 E5
Onto Innovation	2379 E2
Orient Service Corp.	4152 E4
Oxford Instruments	1523 E1
<b>P</b> PacTech-Packaging Technologies GmbH	5373 E5
Park Systems Corp.	7549 E7
Parker Hannifin Motion & Control (Shanghai) Co., Ltd.	6715 E6
Particle Measuring Systems, Inc.	3153 E3

## SEMICON 2020 Exhibitors List

Company	Booth Hall
PEER Group Inc.	7663 E7
Pentamaster Equipment Manufacturing Sdn Bhd.	4167 E4
PerkinElmer Management (Shanghai) Co., Ltd	7828 E7
Pfeiffer Vacuum (Shanghai) Co., Ltd	2601 E2
PFK Co., Ltd.	6631 E6
PHST Corporation.	7170 E7
PI Physik Instrumente (PI Shanghai) Co.,Ltd	3663 E3
Picosun Oy	2730 E2
Planar JSC	7132 E7
PNC Process Systems Co.,Ltd.	2363 E2
PowerTech Co., Ltd.	4659 E4
Precision Electronic Technology (Suzhou) Co., Ltd.	1456 E1
Precision Polymer Engineering Ltd.	3130 E3
ProbeLeader Co., Ltd	2146 E2
PROBING GROUP	4623 E4
PROTEC CO., LTD.	4617 E4
PSK Inc.	7523 E7
Pulse-tech (Hongkong) Technology Limited	2748 E2
Puritic Shanghai Corporation	2715 E2
PVA Crystal Growing Systems GmbH	2675 E2
<b>Q</b> Q.D. HDTech Micro electronics Co., Ltd.	6115 E6
Qingdao Fushao Refining & Processing Co., Ltd	1209 E1
Qingdao Gaoce Technology Co.,Ltd	2649 E2
Qingdao Huaqi Technology Co.,Ltd	6008 E6
Qingdao Share Microelectronics Co., Ltd	6131 E6
Qingdao Sunred Electronic Equipment Co., Ltd.	6337 E6
Qingdao Yuhao Microelectronics Equipment Co., Ltd.	4146 E4
Qinghai Huanghe Hydroponer Development Co., Ltd	7469 E7
New Energy Branch	
Qinyang Guoshun Light and Electricity Gas Source of Silicon Co., Ltd	6280 E6
Quality Assurance Management Asia(Shanghai) Co., Ltd.	2806 E2
Qualimax Testech, Inc.	5267 E5
Questar China Ltd.	3119 E3
Quick Gem Optoelectronic S&T Co.,Ltd	2159 E2
<b>R</b> Raenin Materials Co., Ltd	1613 E1
Raith China Co.,Ltd	2774 E2
RAYMOND & CO	2746 E2
RayZher Industrial Co., Ltd	6433 E6
Regentek (Shanghai) Ltd.	4573 E4
Reid-Ashman Manufacturing, Inc.	1308 E1
RENA Technologies GmbH	2772 E2
RIKEN KEIKI Co., Ltd.	7248 E7
RION CO., LTD.	2223 E2
Roehling Engineering Plastics (Suzhou) Co., Ltd	6381 E6
Rokko Electronics Co., Ltd.	6730 E6
ROKKO Systems Pte Ltd	3751 E3
RORZE CORPORATION	3263 E3
Rotarex Ceodeux	1331 E1
RPS CO., LTD.	7713 E7
Ruijixinsheng Electronic Technology (WuXi) Co., Ltd	5177 E5
Ruter Elastomer Co., Ltd	5810 E5
<b>S</b> S.Y. Technology Engineering & Construction Co., Ltd	7671 E7
Saesol Diamond Ind. Co., Ltd.	7725 E7
Saint-Gobain Performance Plastics (Shanghai) Co., Ltd.	5745 E5
Salus Engineering International	3234 E3
Samco Inc.	2531 E2
Samil Tech Co., LTD.	2231 E2
SandTek Semiconductor Technology (Shanghai) Ltd.	1729 E1
Sangyo Times Co., Ltd.	5755 E5
Saratoga Technology International	2559 E2
SAS Semiconductor Technology (Shanghai) Co., Ltd	6759 E6
SAWATEC AG	5775 E5
SCH Electronics (Shanghai) Co., LTD.	3137 E3
scia Systems GmbH	2263 E2
SE Technologies Corp.	3375 E3
Seal Tech Welded Bellows (Liaoning) Co., Ltd.	2253 E2
SEC Co.,Ltd	7477 E7
SEEDRI Beijing	4423 E4
Seiwa Optical (Shanghai) Co.,Ltd.	2751 E2
Sekisui Chemical Co., Ltd (China)	7775 E7
Selling-Ware Co., Ltd.	3223 E3
SEMCO TECHNOLOGIES	4750 E4
SEMES Co., Ltd.	5363 E5
SemiGlory Electronics (Chongqing) Co., Ltd	6146 E6
Semilab Trade (Shanghai) Co., Ltd	2437 E2
Semiplastic High Purity Material (Kunshan) Co., Ltd	2177 E2

Company	Booth Hall
Semishare Co., Ltd	2729 E2
Sen Huan Electrical Technology Co., Ltd	5126 E5
Senju Metal (Shanghai) Co., Ltd.	2537 E2
SENTECH Instruments GmbH	2623 E2
SET Corporation S.A.	6755 E6
SGL Carbon Far East Ltd. Shanghai	6401 E6
Shandong Gaotang Jiesing Semiconductor Technology Co., Ltd	6119 E6
Shandong Keda Dingxin Electronic Technology Co.,Ltd	2279 E2
Shanghai Amsemi Semiconductor Technology Co., Inc.	2350 E2
Shanghai AfaPa Vacuum Equipment Co.,Ltd	6330 E6
Shanghai AllinABC Cloud Technology Co.,Ltd	5423-4 E5
Shanghai Ansemi Semiconductor Technology Co., Ltd	7462 E7
Shanghai ANT Piping Systems Co., Ltd	3820 E3
Shanghai Bestity Semiconductor Technology Co., Ltd	6331 E6
Shanghai Brother Microelectronics Technology Co., Ltd.	1419 E1
Shanghai CaiWin Electronics Co., Ltd	6736 E6
Shanghai Chiptube Semiconductor Material Co., Ltd	5806 E5
Shanghai Companion Precision Ceramics Co., Ltd.	5153 E5
Shanghai Dillon Science And Technology Co., Ltd	7535 E7
Shanghai Dongxu Electronic Technology Co., Ltd	4745 E4
SHANGHAI DUKE ELECTRONICS CO., LTD	2273 E2
Shanghai Ebara Precision Machinery Co., Ltd.	4008 E4
Shanghai Fairfield Electronic Technology Co., Ltd	6725 E6
Shanghai Gentech Co., Ltd.	4231 E4
Shanghai GND eTech Co.,Ltd	6116 E6
Shanghai Hanhong Precision Machinery Co., Ltd	2322 E2
Shanghai Heli Industrial Gas Co.,Ltd	3110 E3
SHANGHAI HONG TAI ENVIRONMENT TECHNOLOGY CO.,LTD	6553 E6
Shanghai Hongchuan Electronics Co., Ltd.	1705 E1
Shanghai Hongjun New Energy Materials Co., Ltd	6481 E6
Shanghai Huahong Grace Semiconductor Manufacturing Corporation(Huahong Group)	5435-2 E5
Shanghai Huali Microelectronics Corporation(Huahong Group)	5435-1 E5
Shanghai Huasong Enterprise	4481 E4
Shanghai Icwiser communication Technology Co.,Ltd	7629 E7
Shanghai Integrated Circuit Industry Association	5753 E5
Shanghai Jerine Electromechanical Technology Co.,Ltd	2550 E2
Shanghai Jet Plasma Co.,Ltd	6155 E6
Shanghai JinFu Electromechanical Technology Co., Ltd	5734 E5
Shanghai Jufuorine Plastic Technolgy Co., Ltd	2651 E2
Shanghai JUYA Technology Co.,Ltd	2479 E2
Shanghai Juyue Detection Technology Co.,Ltd	7667 E7
Shanghai Leading Semiconductor Technology Development Co., Ltd.	1276 E1
Shanghai Lieth Precision Equipment Co., Ltd	7677 E7
Shanghai Lush Mount Int'l Trade Ltd.	4257 E4
Shanghai Merlin Test Technologies Co.,Ltd	6247 E6
Shanghai Micro Electronics Equipment (Group) Co., Ltd.	3643 E3
Shanghai Miya Technology Co., Ltd.	7156 E7
Shanghai MOJUNE Electronic Technology Co., Ltd	2652 E2
Shanghai Morn Technology Co., Ltd	2606 E2
Shanghai O-Best Electronic Technology Co., Ltd.	5123 E5
Shanghai PhiChem Material Co., Ltd.	5663 E5
Shanghai Pillar Trading Co., Ltd	7705 E7
SHANGHAI PLUSCO TECH CO., LTD	1706 E1
Shanghai Precision Measurement Semiconductor Technology, Inc	5511 E5
Shanghai Pujiang Specialty Gases Co., Ltd	2725 E2
Shanghai Pulner Filtration Technology Co.,Ltd	7247 E7
Shanghai Qianhua Industrial Corporation	5159 E5
Shanghai Rainbow Welding Engineering Co., Ltd	3780 E3
Shanghai Rhyme New Energy Technology Co., Ltd	5731 E5
Shanghai Ruicun Purification Engineering Co., Ltd	2527 E2
Shanghai Shareway Precision Machinery Co.,Ltd	7239 E7
Shanghai Shengjian Environment Technology Co, Ltd	7339 E7
Shanghai ShengYing Technologies Co.,Ltd	5423-3 E5
Shanghai Shenma Fluid Equipment Co., Ltd.	2277 E2
Shanghai Shuangli Electromechanical Technology Co., Ltd	7529 E7
Shanghai Silicology Scientific & Trading Co., Ltd	5757 E5
Shanghai Simpure Gas Technology Co., Ltd.	2824 E2
Shanghai Sinyang Semiconductor Materials Co., Ltd	5331 E5
Shanghai SNA Equipment Technology Co., Ltd	3167 E3

## SEMICON 2020 Exhibitors List

Company	Booth Hall
Shanghai STN Electrical & Machinery Co., Ltd	7263 E7
Shanghai Supex Industrial Supply Co., Ltd.	6652 E6
Shanghai Takigen Co., Ltd	3735 E3
Shanghai Testrong Technologies Co., Ltd	1130 E1
Shanghai Vastity Electronics Technology Co.,Ltd.	4643 E4
Shanghai Xuyi Electronic Technologies Co., Ltd.	2326 E2
Shanghai Yikang Chemicals & Industries Co. Ltd	7609 E7
Shanghai Yishi Trading Co., Ltd	6745 E6
Shanghai Yodogawa Trading Co.,Ltd	7708 E7
Shanghai Zhonghui Electronics Technology Co., Ltd	2804 E2
Shanghai Zhonghui Electronics Technology Co., Ltd	4276 E4
Shanghai Zhonghui Electronics Technology Co., Ltd	5828 E5
Shaoxing Hongbang Electronics Technology Co., Ltd	4681 E4
SHENNAN CIRCUITS CO., LTD	5517 E5
ShenYang Academy of Instrumentation Science Co., Ltd	3205 E3
Shenyang Fortune Precision Equipment Co., Ltd.	3307 E3
Shenyang Heyan Technology Co.,Ltd	4473 E4
ShenYang Merit Aircraft&Aerospace Materials Co.,LTD	6726 E6
Shenyang Piotech Co., Ltd.	3211 E3
Shenyang SIASUN Robot & Automation Co., Ltd.	3201 E3
Shenyang Silicon Technology Co., Ltd.	3209 E3
Shenzhen Allmerit Technology Co., Ltd.	3713 E3
SHENZHEN BIAOPU SEMICONDUCTOR TECHNOLOGY CO.,LTD	3135 E3
Shenzhen Biaowang Industrial Equipment Co.,Ltd	4372 E4
Shenzhen Bindebao Electronic Technology Co., Ltd	4130 E4
Shenzhen Dejiabao Electronics Co., Ltd	7637 E7
Shenzhen Fountly New Materials Technology Co., Ltd	3733 E3
Shenzhen Grand Technologies Corporation	6136 E6
Shenzhen Guandahong Technology Co., Ltd	6106 E6
Shenzhen HanHwa Semiconductor Technology Co., Ltd	7232 E7
Shenzhen Hans Semi Equipment Technology Co., Ltd	5116 E5
Shenzhen Hiner Advanced Materials Technology Co.,Ltd.	7547 E7
Shenzhen Ingenuity Mfrs Technology Co., Ltd	2280 E2
Shenzhen Inte Laser Technology Co., Ltd	2822 E2
SHENZHEN JINNUODA TEFLON ELECTROTHERMAL TECHNOLOGY Co., Ltd	6629 E6
Shenzhen June's Automation Co., Ltd.	3778 E3
Shenzhen Just Photoelectric Equipment Co., Ltd	6239 E6
Shenzhen Liande Automation Equipment Co., Ltd	6557 E6
Shenzhen Merry Precise Electronic Co.,Ltd	1300 E1
Shenzhen MicroASM Semiconductor Technology Co.,Ltd	2173 E2
Shenzhen Pingchen Semiconductor Technology Co. Ltd	6211 E6
Shenzhen Pure Water No.1 Industry Development Co., Ltd.	7207 E7
Shenzhen Rongda Photosensitive Science & Technology Co., Ltd	7359 E7
Shenzhen Secon Technical Industry Co., Ltd	2810 E2
SHENZHEN SELEN CLEAN TECH Co., Ltd	2014 E2
SHENZHEN XINYICHANG TECHNOLOGY CO., LTD	7577 E7
Shenzhen Yaotong Technology Co., Ltd.	4800 E4
Shibaura Mechatronics Corp.	7655 E7
Shibuya Corporation	7150 E7
Shin-Etsu Polymer Hong Kong Co., Ltd	7228 E7
Sichuan Injet Electric Co., LTD.	4014 E4
SICREAT (Suzhou)Semiconductor Technologies Co., Ltd	2112 E2
Sidea Semiconductor Equipment (Shenzhen) Co.,Ltd	4147 E4
Silpac International Limited	4663 E4
Singulus Technologies AG	4806 E4
Sinochem Lantian Co., Ltd.	7008 E7
SINOPATT Technology Co., Ltd	2228 E2
SIP Hengyue Automation Technology Co., Ltd	5635 E5
SKL Tech Co., Ltd.	2754 E2
SKY Technology Development Co.,Ltd Chinese Academy of Sciences	3313 E3
SL Group	6642 E6
SMC (China) Co., Ltd	1401 E1
Smiths Interconnect	5735 E5
SOLARIUS DEVELOPMENT INC.	2678 E2
Solecon Laboratories	2348 E2
Specho Electronic Technology (Shanghai) Co.,Ltd	7350 E7
Spectrum Materials Corporation Limited	5146 E5
Speedfam Mechtronics (Nanjing) Ltd	2167 E2
Spirox Corporation	3423 E3
SPMC (Changzhou) Co., Ltd.(Semiconductor Precision Machinery)	3230 E3

Company	Booth Hall
Sprint Precision Technologies Co., Ltd	7449 E7
SPT- Small Precision Tools Co., Ltd.	3745 E3
Standard Technology Corporation	6501 E6
SHUGATSUNE SHANGHAI CO.,LTD	6748 E6
Sumika Chemical Analysis Service, Ltd.	7601 E7
Sumika Electronic Materials (Shanghai) Corporation	7601 E7
Sumika Electronic Materials (Changzhou)Co.,Ltd	7601 E7
Sumika Electronic Materials(Xian)Co.,Ltd	7601 E7
Sumitomo Chemical Company, Ltd.	7601 E7
Sumitomo Mitsui Finance and Leasing Co. Ltd.	2637 E2
Sunray New Energy Co., Ltd.	4301 E4
Suntech Co., Ltd	4617 E4
Suntific Materials (Weifang), Ltd	3229 E3
Sunto Semiconductor Technology Shanghai Co., Ltd.	2816 E2
SurplusGLOBAL, Inc.	4101 E4
Suzhou AHD Plastic	2181 E2
Suzhou AK Tech Co., Ltd.	6649 E6
Suzhou Betpak New Material Technology Co., Ltd	7656 E7
Suzhou Crystal Clear Chemical Co., Ltd.	5243 E5
Suzhou CSE Semiconductor Equipment Technology Co., Ltd	7146 E7
SuZhou Guangduo Micro, Nano Devices Co., Ltd	2643 E2
Suzhou HRT Electronic Equipment Technology Co., Ltd	6123 E6
Suzhou HYC Technology Co., Ltd	7543 E7
Suzhou Industrial Park A-Tech Technology Co., Ltd.	1607 E1
Suzhou IV Technologies Co., Ltd	7728 E7
Suzhou Jieruisi Automatic Equipment Co., Ltd	6471 E6
Suzhou Jinhong Gas Co., Ltd	5463 E5
SuZhou JoneSolar New Energy Tech. Co.,Ltd	1201 E1
Suzhou JYD Industrial Co.,Ltd	6135 E6
Suzhou Kematek, Inc	2581 E2
Suzhou Kzone Equipment Technology Co., Ltd	6118 E6
Suzhou MEMStools Semiconductor Technology Co.,Ltd	2166 E2
Suzhou Mica Technology Co., Ltd.	3729 E3
Suzhou Myesde Ultra Clean Technology Co.,Ltd	1725 E1
Suzhou New Star Environment Technology Corp.	6722 E6
SuZhou Peritech Technol Inc	1533 E1
Suzhou Sail Science & Technology Co., Ltd.	3208 E3
Suzhou Servo Dynamics Co.,Ltd	6258 E6
Suzhou Silicon Test System Co., Ltd	7563 E7
Suzhou SLD Electronic Co., Ltd	4407 E4
Suzhou Star Union Technology Co.,Ltd	1357 E1
Suzhou Superlight Micro Electronics Co., Ltd.	3826 E3
Suzhou Suyuan Advantec Machinery Co., Ltd	2259 E2
Suzhou TA&A Ultra Clean Technology Co.,Ltd.	1601 E1
Suzhou Tusen Laser Co., Ltd	2276 E2
Suzhou Yifan Yike New Technology Co.,Ltd	4769 E4
SVCS Process Innovation s.r.o.	2237 E2
Swagelok (Shanghai) Fluid Systems Technologies Co., Ltd	3323 E3
Symtek Automation Asia Co., Ltd.	1014 E1
Synergie Cad GROUP	7666 E7
Synus Tech	6477 E6
Systematic Technology (Shanghai) Co., Ltd.	3725 E3
SZSI-TECH	6816 E6
Tachia Yung Ho Machine Industry Co., Ltd	2705 E2
Taiji Semiconductor (Suzhou) Co., Ltd	5539 E5
Taiwan Carrier Tape Enterprise co., Ltd.	7826 E7
Taiwan Maxwave Co., Ltd.	7243 E7
TankeBlue Semiconductor Co., Ltd.	2101 E2
TAZMO Apprecia Electronics (Shanghai) Inc.	7000 E7
TDG Machinery Technology Co.,Ltd	6101 E6
Technic (China-HK) Limited	5824 E5
Technical & Try Co., Ltd.	6427 E6
Technology Develop Semiconductor Co., Ltd.	3163 E3
Technoprobe	6765 E6
Teesing Industrial Systems (Beijing) Co., Ltd.	6732 E6
Teksoli, Inc.	2750 E2
Teltec Semiconductor Pacific Limited	3343 E3
Teltec Semiconductor Pacific Limited	3352 E3
Teltec Semiconductor Pacific Limited	3354 E3
Teltec Semiconductor Pacific Limited	3355 E3
Tesec Corporation	3816 E3
Test Tooling Solutions Group Pte.Ltd.	4715 E4
Tete Semiconductor Equipment	6705 E6

## SEMICON 2020 Exhibitors List

Company	Booth Hall
TFC	4403 E4
TFE Inc.	----
The 718th research institute of CSIC	5357 E5
The Chemours Chemical (Shanghai) Co., Ltd.	4277 E4
The Fourth Construction Co., Ltd. of China Electronics System Engineering	6343 E6
The IT Electronics Eleventh Design & Research Institute Scientific and Technological	5623 E5
Thin Film Equipment srl	2633 E2
THK (CHINA) CO.,LTD	6355 E6
Tianjin Zhonghuan Semiconductor Co., Ltd.	5455 E5
TMS Technology	4729 E4
TOCALO&HANTAI (KUN SHAN) CO., LTD	7109 E7
Toflo Corporation Shanghai Representative Office	3149 E3
Tokai Carbon (Dalian) Co., Ltd	7515-2 E7
Tokkyokiki Corporation	6268 E6
<b>Tokyo Electron Limited</b>	<b>5411 E5</b>
TOKYO KEISO CO., LTD.	3575 E3
Tokyo Ohka Kogyo Co., Ltd	5215 E5
TOKYO SEIMITSU CO., LTD.	3443 E3
TongChao Precision Machinery Co.,Ltd	7119 E7
TongFu Microelectronics Co.,Ltd.	5501 E5
Tongjin Poonsan Sanjia Microtech Co., Ltd.	7659 E7
Topco Scientific (Shanghai) Co., Ltd.	7223 E7
Toray Engineering Co., Ltd.	4109 E4
Toray Engineering Co., Ltd. : TASMIT, Inc.	4109 E4
Toray Engineering D Solutions Co.,Ltd	4109 E4
Toray Industries Inc	4109 E4
Toray Precision Co.,Ltd.	6766 E6
Toray Research Center, Inc.	4109 E4
Towa Corporation	7343 E7
Toyo Advanced Technologies Co., Ltd.	2627 E2
Toyobishi Corporation	3348 E3
Toyoko Gas Equipments (Shanghai) Co., Ltd.	5812 E5
Trebor International, a Unit of IDEX Corporation	3828 E3
TRUMPF Huettinger Electronics (Shanghai) Co.,Ltd	4367 E6
Trustec Co., Ltd.	5101 E5
TRY Precision Co., Ltd.	3248 E3
TS Tech (Changzhou) Co., Ltd	4667 E4
TSE Co., Ltd.	1473 E1
TSI Instruments (Beijing) Co.,Ltd	6278 E6
TT Vision Technologies SDN BHD	6742 E6
t-WIN IoT Technology (Shanghai) Service Company	7646 E7
<b>U</b> uangyih Clean Engineering (Shanghai) Co., Ltd.	5800 E5
Ueno Seiki Co., Ltd.	3475 E3
UniTemp GmbH	2673 E2
UniTest Inc.	4223 E4
U-Precision Tech Co., Ltd.	4337 E4
Ushio Shanghai, Inc	1637 E1
UVIR CO., LIMITED	7820 E7
<b>V</b> Value Engineering, Ltd.	2607 E2
Victrex PLC	6176 E6
Visino Technology (Xiamen) Co., Ltd	5765 E5
Vital Materials Co., Limited	5429 E5
ViTrox Technologies Sdn. Bhd.	4357 E4
<b>W</b> Wafer Works Corporation	7765 E7
Warwick Instruments (Zhu Hai) Co., Ltd	7612 E7
Weifeng Electronic Products (Kunshan) Co.,Ltd	3623-1 E3
Weihai Jinding Machinery Manufacturing Co.,Ltd	6670 E6
Wenyi Trinity Technology Co., Ltd	3609 E3
Wenzhou Guanbo Instrument Valve Co., Ltd	2352 E2
Wenzhou Zhibo Mechanical Technology Co.,Ltd	5773 E5
WESI Technology Limited	2263 E2

Company	Booth Hall
Whole Link International	3623-1 E3
Wing Loong Equipment (Da Lian) Co., Ltd	3773 E3
Wingzhen Technology (Shenzhen) Co., Ltd.	6423 E6
Wintech-Nano ( Suzhou ) Co., Ltd.	7736 E7
WinWay Technology Co., Ltd.	2745 E2
WinWin Electronic Technology International Limited	3150 E3
Wire Technology Co., Ltd.	4579-1 E4
Wonik IPS Co., Ltd.	3457 E3
Woojin I&S Co., Ltd	2555 E2
World Star Electronic Material Co., LTD TIANJIN	4150 E4
Wuhan Choice Technology Co., Ltd	2234 E2
WuHan MEMS Card Micro Electrical Co., Ltd	2755 E2
WUXI BOBOO HITECH CO.,LTD	2659 E2
Wuxi Jerome Precision Mechanics Co., Ltd.	3765 E3
Wuxi Sky Chip Interconnection Technology Co., Ltd.	5517 E5
Wuxi Songyu Technology Co., Ltd.	6237 E6
<b>WUXI WORLD TRADING CO., LTD</b>	<b>6110 E6</b>
XH Industrial Co., Limited.	2659 E2
Xiamen Baoshili Dustless Technology Co., Ltd.	2170 E2
Xiamen Fuchi Automation Equipment Co.,Ltd.	3808 E3
Xiamen Hengkun New Material Technology Co., Ltd.	5171 E5
Xiamen Twinwin Automation Technology Co., Ltd	6334 E6
Xinxiang Moretec Technology Co.,Ltd	6368 E6
XP Electron International Co.,LTD	3379 E3
<b>Y</b> Yamaichi Electronics Hong Kong Ltd	<b>3106 E3</b>
Yancheng Giga Diamond Materials Corporation	5313 E5
Yangzhou Sipuer Technology Company	6139 E6
Yantai Golden Eagle Technology CO.,LTD	6174 E6
Yantai Yesdo Electronic Materials Co., Ltd	3769 E3
Yaskawa Tsusho (Shanghai) Co., Ltd	6255 E6
Ye Siang Enterprise Co. Ltd	6800 E6
Yongoo Technology Co.,Ltd	6623 E6
Youngin Equipment Solution Technology(YEST)	----
Yu Shyan System Technology Materials Co., Ltd.	6166 E6
YUNIE FLUIDTECHNOLOGY(SHANGHAI) CO.,LTD	6667 E6
YUYU Lighting Co., Ltd.	7363 E7
Yxlon International	2443 E2
<b>Z</b> Zhangjiagang Deyizhou Precision Filter Material Co., Ltd	<b>5808 E5</b>
Zhangjiagang Ultrasonic Electric Co.,Ltd.	2549 E2
Zhejiang Cheer Mechanical & Electrical Technology Co., Ltd	6663 E6
Zhejiang Chip Sunshine Equipment Technology Co., Ltd.	7539 E7
Zhejiang Harog Technology Co.,Ltd	6147 E6
Zhejiang Jingsheng Mechanical & Electrical Co., Ltd.	6201 E6
Zhejiang Kin-sheng Technology Co., LTD	7348 E7
Zhejiang Morita New Materials Co., Ltd	6511 E6
Zhejiang Ruiqun Technology Co., Ltd	6314 E6
Zhejiang Shangneng Industrial Co., LTD	2655 E2
Zhejiang SUNLIKY Material Technology Co.,Ltd	6733 E6
Zhejiang Yuanyao Valve Industry Co., Ltd	4127 E4
Zhejiang Yunfeng New Material Technology Co., Ltd	6439 E6
Zhengzhou Hongtuo Superabrasive Products Co., Ltd.	2611 E2
Zhengzhou Research Institute for Abrasives & Grinding Co., Ltd	2463 E2
Zillion Tek Co., Ltd	4810 E4

## 新增展商

Company	Booth Hall
Zhecheng Huifeng Diamond Science and Technology Co., Ltd	2605 E2
Umicore ChangXin Surface Technology (Jiangmen)	6683 E6
Shanghai Safeslab Technology Co., Ltd	3147 E3

## WFD Pavilion

Company	Booth Hall
AdNaNo-Tek	7808 E7
Applied Materials	7814 E7
Edwards Technologies Trading (Shanghai) Co., Ltd.	7474 E7
HUAHONG GROUP	7478 E7
KLA Corporation	7476 E7
Kosma Membrane Technology Co., Ltd.	7800 E7
Kunshan Asia Union Electronic Chemical Corp.Co.,Ltd	7812 E7
PV Vacuum Engineering Pte Ltd	7810 E7
Schneider Electric (China) Co., Ltd.	7480 E7
Shaoming IC Industry Committee	7482 E7
SHENZHEN DGT CO.,LTD	7804 E7

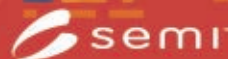


# EXHIBITORS LIST

## FPD 2020 Exhibitors List

Company	Booth	Hall	Company	Booth	Hall
<b>A</b> American Membrane (Nan Tong) Co., Ltd	4673	E4	Kromax International (Shanghai) Corp.	1101	E1
AnHui Hongshi Automation Equipment Co., Ltd	1451	E1	Kyosan Electric Mfg. Co., Ltd.	1463	E1
AP SYSTEMS CORPORATION	1457	E1	<b>L</b> LINTEC Co., Ltd.	1126	E1
APPLY TECH CO., LTD.	1235	E1	Luoyang Sifon Electronic Co., Ltd	1667	E1
Asia IC Mic-Process, Inc.	1330	E1	<b>M</b> M.Braun Inertgas Systems (Shanghai) Co., Ltd	1681	E1
ATEN China Co., Ltd	1114	E1	MAGNEX CO., LTD.	1173	E1
Atlas Copco (Shanghai) Trading Co., Ltd	1230	E1	MAT PLUS Co., Ltd	1139	E1
<b>B</b> BBS Kinmei Co., Ltd.	1755	E1	Maxclean Technology (Wuxi) Co., Ltd	1155	E1
Beijing Gmpower Tech Co., Ltd	1753	E1	<b>N</b> Naraenanotech	---	---
Beijing Plastics Research Institute	1217	E1	New Energy Technology Co., Ltd	1316	E1
Boyue Instruments (Shanghai) Co., Ltd.	1150	E1	Nexensor Inc	1342	E1
Busch Vacuum (Shanghai) Co., Ltd.	1559	E1	<b>O</b> NICHIAS (Shanghai) Trading Co., Ltd.	1246	E1
<b>C</b> C Sun Mfg Ltd.	1206	E1	Osaka Vacuum, Ltd.	1110	E1
Cangzhou Sunheat Chemicals Co.,Ltd.	1115	E1	<b>P</b> PLANSEE SE	---	---
Canon Optical Industrial Equipment (Shanghai) Ltd	1301	E1	Pureach Tech (Beijing) Ltd.	1676	E1
Cassion Technology Development Ltd	1147	E1	<b>R</b> RADIATION TECHNOLOGY (Shanghai) CO.,LTD	1778	E1
Chongqing Tonghui Kefa Gas Co. LTD	1250	E1	<b>S</b> SEBA Inc.	1481	E1
CMDL Co.,Ltd	1344	E1	Shanghai Glorysoft Co., Ltd.	1812	E1
Creating Nano Technologies, Inc.	1336	E1	Shanghai Hanbell Precises Machinery Co., Ltd.	1143	E1
<b>D</b> DAIHEN Corporation	1008	E1	Shanghai Haogu Industrial Co., Ltd	1136	E1
Dalian F.T.Z CREDIT Chemical Technology Development Co., Ltd.	1219	E1	Shanghai Inova Technology Co., Ltd.	1109	E1
<b>E</b> Edwards Technologies Trading (Shanghai) Co., Ltd.	1323	E1	Shanghai Kaisite Steel Pipe Group Co., Ltd	1234	E1
EM-TECHNIK EAST ASIA LTD.	1154	E1	Shanghai Kingwill Technology Co.,Ltd	1273	E1
ENF Technology	1373	E1	Shanghai Xiangzhuo Vacuum Hose Co., Ltd	1156	E1
<b>F</b> FLUONICS Co., Ltd	1281	E1	Shenzhen Newway Photomask Making Co., Ltd.	1573	E1
Foshan Shunde Topcod Industrial Co., Ltd	1756	E1	Simax Asia Pacific Limited	1135	E1
FUJIAN ACETRON New Materials Co., Ltd	1379	E1	Solar Chemical Applied Materials Technology (Kunshan) Co.,Ltd	1663	E1
<b>G</b> Gallant Precision Machining Co., Ltd.	1231	E1	Sung Engineering Co.,Ltd.	1267	E1
Gentec (Shanghai) Corporation	1179	E1	Sungdo Eng	---	---
Geowell Vacuum Co., Ltd	1654	E1	Suzhou Honbest Ultra Clean Technology Co., Ltd	1581	E1
Germanlitho Co.,Ltd	1359	E1	Suzhou Kechengyuan Electronic Technology Co., Ltd.	1177	E1
<b>H</b> H.C.Starck, Inc.	1567	E1	Suzhou U-air Environmental Technology Co., Ltd.	1107	E1
Hangzhou Greenda Electronic Materials Co., Ltd.	1123	E1	SVG TECH GROUP	1226	E1
Henan Xinlianxin Shenleng Energy Co., Ltd	1131	E1	Syscos Instruments Co.,Ltd.	1577	E1
Heraeus Deutschland GmbH & Co. KG	1163	E1	<b>T</b> Ta Liang Technology Co., Ltd.	1673	E1
Highlight Tech (Shanghai) Corp	1800	E1	Taicang Thintech Materials Co., Ltd	1127	E1
Hightec Systems Corporation	1223	E1	TDG HOLDING CO.,LTD.	1167	E1
Hua Laser Electro-Optics Co.,Ltd	1765	E1	Tem Trade (Shanghai) Co., Ltd	1677	E1
Hugle Electronics, Inc.	1551	E1	<b>U</b> ULVAC (Shanghai) Trading Co. Ltd.	1409	E1
<b>I</b> IST METZ GmbH	1745	E1	Unicorn Technology Co., Ltd	1311	E1
<b>J</b> Jesagi Hankook Ltd.	1166	E1	<b>V</b> V TEX Corporation	1146	E1
Jiangsu Chinaite Anticorrosion Technology Co., Ltd	1653	E1	VAT Vacuum Valves (Shanghai) Co. Ltd	1317	E1
Jiangsu Hantop Photo-Materials Co.,Ltd	1254	E1	Vero Veria Corporation	1769	E1
Jiangxi Vei Semiconductor Equipment Co., Ltd	1659	E1	Vigor Gas Purification Technologies (Suzhou) Co., Ltd	1376	E1
<b>K</b> Kenmec Mechanical Engineering Co., Ltd.	1000	E1	<b>W</b> Winifred International Technology (Shanghai) Ltd.	1443	E1
Kenmec Mechanical Engineering Co., Ltd.	1101	E1	Wujiang Jujie Microfibers Clean Textiles Co., Ltd	1116	E1
King Lai Hygienic Materials Co., Ltd.	1335	E1	<b>X</b> Xiamen Honglu Tungsten Molybdenum Industry Co., Ltd	1159	E1
K-MAC	1808	E1	<b>Z</b> Zhangjiagang Parkson Package Material Co., Ltd	1106	E1
KOTRA (Korea Trade-Investment Promotion Agency)	1346	E1	Zhejiang Micromagneticprecision Technology Co., Ltd	1816	E1
Kromax International (Shanghai) Corp.	1000	E1			

### 合作媒体



# 轻松玩转SEMI芯币 兑换好礼!



如何快速赚取芯币请扫码  
或SEMI公众号回复“芯币”

SEMI芯币商城



# 快来集赞抽奖! 100%中奖

和展会现场SEMI 50周年LOGO或SEMICON CHINA LOGO合影, 发送照片在朋友圈集赞30个以上, 即可在SEMI礼品兑换中心 (E4523展位)参与抽奖活动, 中奖率100%. 奖品有限, 先到先得哦!



奖品包括: 京东购物卡、SEMI精美摇粒绒马甲、小米充电宝...